

# TS5A3167 0.9Ω、1チャネルの1:1 SPSTアナログ・スイッチ

## 1 特長

- 電源オフ・モード、 $V_{CC} = 0$ 時に絶縁
- 低いオン抵抗(0.9Ω)
- 制御入力は5.5V許容
- 低い電荷注入
- 低い全高調波歪(THD)
- 1.65V~5.5Vの単電源で動作
- JESD 78, Class II準拠で100mA超のラッチアップ性能
- ESD性能はJESD 22に準拠しテスト済み
  - 人体モデルで2000V (A114-B、クラスII)
  - 1000V、荷電デバイス・モデル(C101)

## 2 アプリケーション

- 携帯電話
- PDA
- ポータブル機器
- オーディオおよびビデオ信号のルーティング
- 低電圧のデータ収集システム
- 通信用回路
- モデム
- ハードディスク
- コンピュータ・ペリフェラル
- ワイヤレス端末およびペリフェラル
- マイクロフォンのスイッチ - ノートブック・ドッキング

## 3 概要

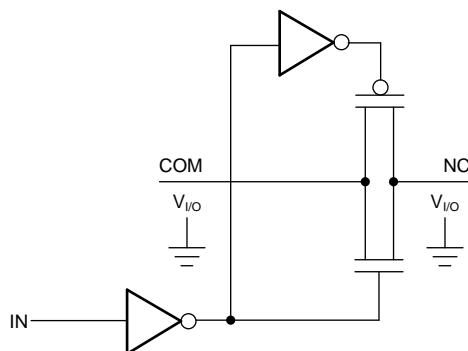
TS5A3167は双方向、シングル・チャネルの单極双投(SPDT)アナログ・スイッチであり、1.65V~5.5Vで動作するよう設計され、オン抵抗が低い特徴があります。このデバイスは全高調波歪み(THD)特性が非常に優れており、極めて低消費電力です。これらの特長から、このデバイスは携帯用オーディオ・アプリケーションに適しています。

### 製品情報<sup>(1)</sup>

型番	パッケージ	本体サイズ(公称)
TS5A3167	SOT-23	2.90mm×1.60mm
	SC70	2.00mm×1.25mm
	DSBGA	1.50mm×0.90mm

(1) 提供されているすべてのパッケージについては、データシートの末尾にある注文情報を参照してください。

### 単純な回路図



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## 4 改訂履歴

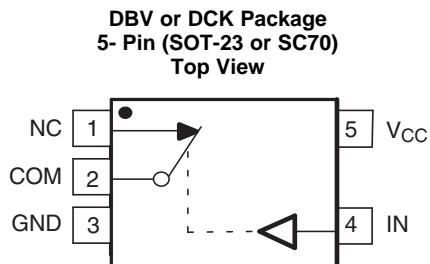
資料番号末尾の英字は改訂を表しています。その改訂履歴は英語版に準じています。

Revision B (March 2017) から Revision C に変更	Page
• 「製品情報」表でDSBGA本体サイズを「1.50mmx9.00mm」から「1.50mmx0.90mm」に変更	1
• Changed the YZP package pinout view From: Top View To: Bottom View	3

Revision A (October 2012) から Revision B に変更	Page
• 「製品情報」表、「ピン構成および機能」セクション、「ESD定格」セクション、「推奨動作条件」セクション、「熱に関する情報」セクション、「詳細説明」セクション、「機能説明」セクション、「デバイスの機能モード」セクション、「アプリケーションと実装」セクション、「電源に関する推奨事項」セクション、「レイアウト、デバイス、およびドキュメントのサポート」セクションを追加	1
• 「注文情報」表を削除	1

2005年2月発行のものから更新	Page
• 「注文情報」表を更新	1

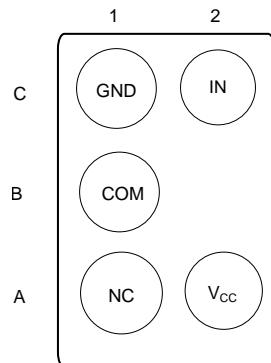
## 5 Pin Configuration and Functions



**Pin Functions**

PIN NUMBER	NAME	DESCRIPTION
1	NC	Normally Closed
2	COM	Common
3	GND	Ground
4	IN	Digital control pin, COM connected to NC when logic low
5	V <sub>CC</sub>	Power Supply

**YZP Package  
5-Pin (DSBGA)  
Bottom View**



**Pin Functions**

PIN NUMBER	NAME	DESCRIPTION
A1	NC	Normally Closed
B1	COM	Common
C1	GND	Ground
A2	V <sub>CC</sub>	Power Supply
C2	IN	Digital control pin, COM connected to NC when logic low

## 6 Specifications

### 6.1 Absolute Maximum Ratings<sup>(1)(2)</sup>

over operating free-air temperature range (unless otherwise noted)

			MIN	MAX	UNIT
$V_{CC}$	Supply voltage range <sup>(3)</sup>		-0.5	6.5	V
$V_{NC}$ $V_{COM}$	Analog voltage range <sup>(3)(4)(5)</sup>		-0.5	$V_{CC} + 0.5$	V
$I_K$	Analog port diode current	$V_{NC}, V_{COM} < 0$	-50		mA
$I_{NC}$ $I_{COM}$	On-state switch current	$V_{NC}, V_{COM} = 0$ to $V_{CC}$	-200	200	mA
	On-state peak switch current <sup>(6)</sup>		-400	400	
$V_I$	Digital input voltage range <sup>(3)(4)</sup>		-0.5	6.5	V
$I_{IK}$	Digital clamp current	$V_I < 0$	-50		mA
$I_{CC}$	Continuous current through $V_{CC}$			100	mA
$I_{GND}$	Continuous current through GND		-100		mA
$T_{stg}$	Storage temperature range		-65	150	°C

- (1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum.
- (3) All voltages are with respect to ground, unless otherwise specified.
- (4) The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
- (5) This value is limited to 5.5 V maximum.
- (6) Pulse at 1-ms duration < 10% duty cycle.

### 6.2 ESD Ratings

		VALUE	UNIT
$V_{(ESD)}$	Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup>	±2000	V
	Charged-device model (CDM), per JEDEC specification JESD22-C101 <sup>(2)</sup>	±1000	

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.
- (2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

### 6.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

		MIN	MAX	UNIT
$V_{CC}$	Supply voltage range	1.65	5.5	V
$V_{NC}$ $V_{COM}$	Analog voltage range	0	$V_{CC}$	V
$V_I$	Digital input voltage range	0	$V_{CC}$	V

### 6.4 Thermal Information

THERMAL METRIC <sup>(1)</sup>	TS5A3167			UNIT
	DBV (SOT-23)	DCK (SOT-23)	YZP (DSBGA)	
	5 PINS	5 PINS	5 PINS	
$R_{\theta JA}$	230.3	268.0	146.2	°C/W
$R_{\theta JC(\text{top})}$	111.9	171.8	1.4	°C/W
$R_{\theta JB}$	69.5	64.5	39.3	°C/W
$\Psi_{JT}$	33.0	40.5	0.7	°C/W
$\Psi_{JB}$	69.0	62.9	39.8	°C/W
$R_{\theta JC(\text{bot})}$	n/a	n/a	n/a	°C/W

- (1) For more information about traditional and new thermal metrics, see the [Semiconductor and IC Package Thermal Metrics](#) application report.

## 6.5 Electrical Characteristics for 5-V Supply<sup>(1)</sup>

$V_{CC} = 4.5 \text{ V}$  to  $5.5 \text{ V}$ ,  $T_A = -40^\circ\text{C}$  to  $85^\circ\text{C}$  (unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITIONS		$T_A$	$V_{CC}$	MIN	TYP	MAX	UNIT
<b>Analog Switch</b>									
Peak ON resistance	$r_{peak}$	$0 \leq V_{NC} \leq V_{CC}$ , $I_{COM} = -100 \text{ mA}$ ,	Switch ON, See Figure 13	25°C	4.5 V	0.8	1.1	$\Omega$	
				Full		1.2			
ON-state resistance	$r_{on}$	$V_{NC} = 2.5 \text{ V}$ , $I_{COM} = -100 \text{ mA}$ ,	Switch ON, See Figure 13	25°C	4.5 V	0.75	0.9	$\Omega$	
				Full		1			
ON-state resistance flatness	$r_{on(flat)}$	$0 \leq V_{NC} \leq V_{CC}$ , $I_{COM} = -100 \text{ mA}$ ,	Switch ON, See Figure 13	25°C	4.5 V	0.2		$\Omega$	
		$V_{NC} = 1 \text{ V}, 1.5 \text{ V}, 2.5 \text{ V}$ , $I_{COM} = -100 \text{ mA}$ ,		25°C		0.15	0.25		
		Full		Full		0.25			
NC OFF leakage current	$I_{NC(OFF)}$	$V_{NC} = 1 \text{ V}$ , $V_{COM} = 4.5 \text{ V}$ , or $V_{NC} = 4.5 \text{ V}$ , $V_{COM} = 1 \text{ V}$ ,	Switch OFF, See Figure 14	25°C	5.5 V	0	4	20	$nA$
				Full		-150		150	
	$I_{NC(PWROFF)}$	$V_{NC} = 0$ to $5.5 \text{ V}$ , $V_{COM} = 5.5 \text{ V}$ to $0$ ,		25°C	0 V	-10	0.2	10	$\mu A$
				Full		-50		50	
COM OFF leakage current	$I_{COM(OFF)}$	$V_{COM} = 1 \text{ V}$ , $V_{NC} = 4.5 \text{ V}$ , or $V_{COM} = 4.5 \text{ V}$ , $V_{NC} = 1 \text{ V}$ ,	Switch OFF, See Figure 14	25°C	5.5 V	0	4	20	$nA$
				Full		-150		150	
	$I_{COM(PWROFF)}$	$V_{COM} = 5.5 \text{ V}$ to $0$ , $V_{NC} = 0$ to $5.5 \text{ V}$ ,		25°C	0 V	-10	0.2	10	$\mu A$
				Full		-50		50	
NC ON leakage current	$I_{NC(ON)}$	$V_{NC} = 1 \text{ V}$ , $V_{COM} = \text{Open}$ , or $V_{NC} = 4.5 \text{ V}$ , $V_{COM} = \text{Open}$ ,	Switch ON, See Figure 15	25°C	5.5 V	-5	0.4	5	$nA$
				Full		-50		50	
COM ON leakage current	$I_{COM(ON)}$	$V_{COM} = 1 \text{ V}$ , $V_{NC} = \text{Open}$ , or $V_{COM} = 4.5 \text{ V}$ , $V_{NC} = \text{Open}$ ,	Switch ON, See Figure 15	25°C	5.5 V	-5	0.4	5	$nA$
				Full		-20		20	
<b>Digital Control Inputs (IN)</b>									
Input logic high	$V_{IH}$			Full		2.4	5.5		V
Input logic low	$V_{IL}$			Full		0	0.8		V
Input leakage current	$I_{IH}, I_{IL}$	$V_I = 5.5 \text{ V}$ or $0$	Switch ON, See Figure 15	25°C	5.5 V	-2	0.3	2	$nA$
				Full		-20		20	

(1) The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum.

## 6.6 Electrical Characteristics for 5-V Supply<sup>(1)</sup> (continued)

$V_{CC} = 4.5 \text{ V}$  to  $5.5 \text{ V}$ ,  $T_A = -40^\circ\text{C}$  to  $85^\circ\text{C}$  (unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITIONS		T <sub>A</sub>	V <sub>CC</sub>	MIN	TYP	MAX	UNIT
<b>Dynamic</b>									
Turn-on time	t <sub>ON</sub>	$V_{COM} = V_{CC}$ , $R_L = 50 \Omega$ ,	$C_L = 35 \text{ pF}$ , See <a href="#">Figure 17</a>	25°C	5 V	1	4.5	7.5	ns
				Full	4.5 V to 5.5 V	1		9	
Turn-off time	t <sub>OFF</sub>	$V_{COM} = V_{CC}$ , $R_L = 50 \Omega$ ,	$C_L = 35 \text{ pF}$ , See <a href="#">Figure 17</a>	25°C	5 V	4.5	8	11	ns
				Full	4.5 V to 5.5 V	3.5		13	
Charge injection	Q <sub>C</sub>	$V_{GEN} = 0$ , $R_{GEN} = 0$ ,	$C_L = 1 \text{ nF}$ , See <a href="#">Figure 20</a>	25°C	5 V		6		pC
NC OFF capacitance	C <sub>NC(OFF)</sub>	$V_{NC} = V_{CC}$ or GND,	Switch OFF, See <a href="#">Figure 16</a>	25°C	5 V		19		pF
COM OFF capacitance	C <sub>COM(OFF)</sub>	$V_{COM} = V_{CC}$ or GND,	Switch OFF, See <a href="#">Figure 16</a>	25°C	5 V		18		pF
NC ON capacitance	C <sub>NC(ON)</sub>	$V_{NC} = V_{CC}$ or GND,	Switch ON, See <a href="#">Figure 16</a>	25°C	5 V		35.5		pF
COM ON capacitance	C <sub>COM(ON)</sub>	$V_{COM} = V_{CC}$ or GND,	Switch ON, See <a href="#">Figure 16</a>	25°C	5 V		35.5		pF
Digital input capacitance	C <sub>I</sub>	$V_I = V_{CC}$ or GND,	See <a href="#">Figure 16</a>	25°C	5 V		2		pF
Bandwidth	BW	$R_L = 50 \Omega$ ,	Switch ON, See <a href="#">Figure 18</a>	25°C	5 V		150		MHz
OFF isolation	O <sub>ISO</sub>	$R_L = 50 \Omega$ , $f = 1 \text{ MHz}$ ,	Switch OFF, See <a href="#">Figure 19</a>	25°C	5 V		-62		dB
Total harmonic distortion	THD	$R_L = 600 \Omega$ , $C_L = 50 \text{ pF}$ ,	$f = 20 \text{ Hz}$ to $20 \text{ kHz}$ , See <a href="#">Figure 21</a>	25°C	5 V		0.005%		
<b>Supply</b>									
Positive supply current	I <sub>CC</sub>	$V_I = V_{CC}$ or GND,	Switch ON or OFF	25°C	5.5 V	0.01	0.1	1	μA
				Full					

(1) The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum.

## 6.7 Electrical Characteristics for 3.3-V Supply<sup>(1)</sup>

$V_{CC} = 3\text{ V}$  to  $3.6\text{ V}$ ,  $T_A = -40^\circ\text{C}$  to  $85^\circ\text{C}$  (unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITIONS		$T_A$	$V_{CC}$	MIN	TYP	MAX	UNIT
<b>Analog Switch</b>									
Peak ON resistance	$r_{peak}$	$0 \leq V_{NC} \leq V_{CC}$ , $I_{COM} = -100\text{ mA}$ ,	Switch ON, See <a href="#">Figure 13</a>	25°C	3 V	1.3	1.6	$\Omega$	
				Full		1.8			
ON-state resistance	$r_{on}$	$V_{NC} = 2\text{ V}$ , $I_{COM} = -100\text{ mA}$ ,	Switch ON, See <a href="#">Figure 13</a>	25°C	3 V	1.1	1.5	$\Omega$	
				Full		1.7			
ON-state resistance flatness	$r_{on(flat)}$	$0 \leq V_{NC} \leq V_{CC}$ , $I_{COM} = -100\text{ mA}$ ,	Switch ON, See <a href="#">Figure 13</a>	25°C	3 V	0.3		$\Omega$	
		$V_{NC} = 2\text{ V}, 0.8\text{ V}$ , $I_{COM} = -100\text{ mA}$ ,		25°C		0.15	0.25		
		Full		Full		0.25			
NC OFF leakage current	$I_{NC(OFF)}$	$V_{NC} = 1\text{ V}$ , $V_{COM} = 3\text{ V}$ , or $V_{NC} = 3\text{ V}$ , $V_{COM} = 1\text{ V}$ ,	Switch OFF, See <a href="#">Figure 14</a>	25°C	3.6 V	-5	0.5	5	$nA$
				Full		-50		50	
	$I_{NC(PWROFF)}$	$V_{NC} = 0$ to $3.6\text{ V}$ , $V_{COM} = 3.6\text{ V}$ to 0,		25°C	0 V	-5	0.1	5	$\mu A$
				Full		-25		25	
COM OFF leakage current	$I_{COM(OFF)}$	$V_{COM} = 1\text{ V}$ , $V_{NC} = 3\text{ V}$ , or $V_{COM} = 3\text{ V}$ , $V_{NC} = 1\text{ V}$ ,	Switch OFF, See <a href="#">Figure 14</a>	25°C	3.6 V	-5	0.5	5	$nA$
				Full		-50		50	
	$I_{COM(PWROFF)}$	$V_{COM} = 3.6\text{ V}$ to 0, $V_{NC} = 0$ to $3.6\text{ V}$ ,		25°C	0 V	-5	0.1	5	$\mu A$
				Full		-25		25	
NC ON leakage current	$I_{NC(ON)}$	$V_{NC} = 1\text{ V}$ , $V_{COM} = \text{Open}$ , or $V_{NC} = 3\text{ V}$ , $V_{COM} = \text{Open}$ ,	Switch ON, See <a href="#">Figure 15</a>	25°C	3.6 V	-2	0.3	2	$nA$
				Full		-20		20	
COM ON leakage current	$I_{COM(ON)}$	$V_{COM} = 1\text{ V}$ , $V_{NC} = \text{Open}$ , or $V_{COM} = 3\text{ V}$ , $V_{NC} = \text{Open}$ ,	Switch ON, See <a href="#">Figure 15</a>	25°C	3.6 V	-2	0.3	2	$nA$
				Full		-20		20	
<b>Digital Control Inputs (IN)</b>									
Input logic high	$V_{IH}$			Full		2	5.5		V
Input logic low	$V_{IL}$			Full		0	0.8		V
Input leakage current	$I_{IH}, I_{IL}$	$V_I = 5.5\text{ V}$ or 0	Switch ON, See <a href="#">Figure 15</a>	25°C	3.6 V	-2	0.3	2	$nA$
				Full		-20		20	

(1) The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum.

## 6.8 Electrical Characteristics for 3.3-V Supply<sup>(1)</sup> (continued)

$V_{CC} = 3\text{ V}$  to  $3.6\text{ V}$ ,  $T_A = -40^\circ\text{C}$  to  $85^\circ\text{C}$  (unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITIONS	$T_A$	$V_{CC}$	MIN	TYP	MAX	UNIT
<b>Dynamic</b>								
Turn-on time	$t_{ON}$	$V_{COM} = V_{CC}$ , $R_L = 50\ \Omega$ ,	$C_L = 35\ \text{pF}$ , See Figure 17	25°C	3.3 V	1.5	5	9.5
				Full	3 V to 3.6 V	1.0	10	ns
Turn-off time	$t_{OFF}$	$V_{COM} = V_{CC}$ , $R_L = 50\ \Omega$ ,	$C_L = 35\ \text{pF}$ , See Figure 17	25°C	3.3 V	4.5	8.5	11
				Full	3 V to 3.6 V	3	12.5	ns
Charge injection	$Q_C$	$V_{GEN} = 0$ , $R_{GEN} = 0$ ,	$C_L = 1\ \text{nF}$ , See Figure 20	25°C	3.3 V	6		pC
NC OFF capacitance	$C_{NC(OFF)}$	$V_{NC} = V_{CC}$ or GND,	Switch OFF, See Figure 16	25°C	3.3 V	19.5		pF
COM OFF capacitance	$C_{COM(OFF)}$	$V_{COM} = V_{CC}$ or GND,	Switch OFF, See Figure 16	25°C	3.3 V	18.5		pF
NC ON capacitance	$C_{NC(ON)}$	$V_{NC} = V_{CC}$ or GND,	Switch ON, See Figure 16	25°C	3.3 V	36		pF
COM ON capacitance	$C_{COM(ON)}$	$V_{COM} = V_{CC}$ or GND,	Switch ON, See Figure 16	25°C	3.3 V	36		pF
Digital input capacitance	$C_I$	$V_I = V_{CC}$ or GND,	See Figure 16	25°C	3.3 V	2		pF
Bandwidth	BW	$R_L = 50\ \Omega$ ,	Switch ON, See Figure 18	25°C	3.3 V	150		MHz
OFF isolation	$O_{ISO}$	$R_L = 50\ \Omega$ , $f = 1\ \text{MHz}$ ,	Switch OFF, See Figure 19	25°C	3.3 V	-62		dB
Total harmonic distortion	THD	$R_L = 600\ \Omega$ , $C_L = 50\ \text{pF}$ ,	$f = 20\ \text{Hz}$ to $20\ \text{kHz}$ , See Figure 21	25°C	3.3 V	0.01%		
<b>Supply</b>								
Positive supply current	$I_{CC}$	$V_I = V_{CC}$ or GND,	Switch ON or OFF	25°C	3.6 V	0.001	0.05	$\mu\text{A}$
				Full		0.3		

(1) The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum.

## 6.9 Electrical Characteristics for 2.5-V Supply<sup>(1)</sup>

$V_{CC} = 2.3\text{ V}$  to  $2.7\text{ V}$ ,  $T_A = -40^\circ\text{C}$  to  $85^\circ\text{C}$  (unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITIONS		$T_A$	$V_{CC}$	MIN	TYP	MAX	UNIT
<b>Analog Switch</b>									
Peak ON resistance	$r_{peak}$	$0 \leq V_{NC} \leq V_{CC}$ , $I_{COM} = -100\text{ mA}$ ,	Switch ON, See <a href="#">Figure 13</a>	25°C	2.3 V	1.8	2.4	$\Omega$	
				Full		2.6			
ON-state resistance	$r_{on}$	$V_{NC} = 2\text{ V}$ , $I_{COM} = -100\text{ mA}$ ,	Switch ON, See <a href="#">Figure 13</a>	25°C	2.3 V	1.2	2.1	$\Omega$	
				Full		2.4			
ON-state resistance flatness	$r_{on(flat)}$	$0 \leq V_{NC} \leq V_{CC}$ , $I_{COM} = -100\text{ mA}$ ,	Switch ON, See <a href="#">Figure 13</a>	25°C	2.3 V	0.7		$\Omega$	
		$V_{NC} = 2\text{ V}, 0.8\text{ V}$ , $I_{COM} = -100\text{ mA}$ ,		25°C		0.4	0.6		
		Full		Full		0.6			
NC OFF leakage current	$I_{NC(OFF)}$	$V_{NC} = 1\text{ V}$ , $V_{COM} = 3\text{ V}$ , or $V_{NC} = 3\text{ V}$ , $V_{COM} = 1\text{ V}$ ,	Switch OFF, See <a href="#">Figure 14</a>	25°C	2.7 V	-5	0.3	5	$nA$
				Full		-50		50	
	$I_{NC(PWROFF)}$	$V_{NC} = 0$ to $3.6\text{ V}$ , $V_{COM} = 3.6\text{ V}$ to $0$ ,		25°C	0 V	-2	0.05	2	$\mu A$
				Full		-15		15	
COM OFF leakage current	$I_{COM(OFF)}$	$V_{COM} = 1\text{ V}$ , $V_{NC} = 3\text{ V}$ , or $V_{COM} = 3\text{ V}$ , $V_{NC} = 1\text{ V}$ ,	Switch OFF, See <a href="#">Figure 14</a>	25°C	2.7 V	-5	0.3	5	$nA$
				Full		-50		50	
	$I_{COM(PWROFF)}$	$V_{COM} = 3.6\text{ V}$ to $0$ , $V_{NC} = 0$ to $3.6\text{ V}$ ,		25°C	0 V	-2	0.05	2	$\mu A$
				Full		-15		15	
NC ON leakage current	$I_{NC(ON)}$	$V_{NC} = 1\text{ V}$ , $V_{COM} = \text{Open}$ , or $V_{NC} = 3\text{ V}$ , $V_{COM} = \text{Open}$ ,	Switch ON, See <a href="#">Figure 15</a>	25°C	2.7 V	-2	0.3	2	$nA$
				Full		-20		20	
COM ON leakage current	$I_{COM(ON)}$	$V_{COM} = 1\text{ V}$ , $V_{NC} = \text{Open}$ , or $V_{COM} = 3\text{ V}$ , $V_{NC} = \text{Open}$ ,	Switch ON, See <a href="#">Figure 15</a>	25°C	2.7 V	-2	0.3	2	$nA$
				Full		-20		20	
<b>Digital Control Inputs (IN)</b>									
Input logic high	$V_{IH}$			Full		1.8	5.5	$V$	
Input logic low	$V_{IL}$			Full		0	0.6	$V$	
Input leakage current	$I_{IH}, I_{IL}$	$V_I = 5.5\text{ V}$ or $0$		25°C	2.7 V	-2	0.3	2	$nA$
				Full		-20		20	

(1) The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum.

## 6.10 Electrical Characteristics for 2.5-V Supply<sup>(1)</sup> (continued)

$V_{CC} = 2.3\text{ V}$  to  $2.7\text{ V}$ ,  $T_A = -40^\circ\text{C}$  to  $85^\circ\text{C}$  (unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITIONS		$T_A$	VCC	MIN	TYP	MAX	UNIT
<b>Dynamic</b>									
Turn-on time	$t_{ON}$	$V_{COM} = V_{CC}$ , $R_L = 50\ \Omega$ ,	$C_L = 35\ \text{pF}$ , See <a href="#">Figure 17</a>	25°C	2.5 V	2	6	10	ns
				Full	2.3 V to 2.7 V	1		12	
Turn-off time	$t_{OFF}$	$V_{COM} = V_{CC}$ , $R_L = 50\ \Omega$ ,	$C_L = 35\ \text{pF}$ , See <a href="#">Figure 17</a>	25°C	2.5 V	4.5	8	10.5	ns
				Full	2.3 V to 2.7 V	3		15	
Charge injection	$Q_C$	$V_{GEN} = 0$ , $R_{GEN} = 0$ ,	$C_L = 1\ \text{nF}$ , See <a href="#">Figure 20</a>	25°C	2.5 V		4		pC
NC OFF capacitance	$C_{NC(OFF)}$	$V_{NC} = V_{CC}$ or GND,	Switch OFF, See <a href="#">Figure 16</a>	25°C	2.5 V		19.5		pF
COM OFF capacitance	$C_{COM(OFF)}$	$V_{COM} = V_{CC}$ or GND,	Switch OFF, See <a href="#">Figure 16</a>	25°C	2.5 V		18.5		pF
NC ON capacitance	$C_{NC(ON)}$	$V_{NC} = V_{CC}$ or GND,	Switch ON, See <a href="#">Figure 16</a>	25°C	2.5 V		36.5		pF
COM ON capacitance	$C_{COM(ON)}$	$V_{COM} = V_{CC}$ or GND,	Switch ON, See <a href="#">Figure 16</a>	25°C	2.5 V		36.5		pF
Digital input capacitance	$C_I$	$V_I = V_{CC}$ or GND,	See <a href="#">Figure 16</a>	25°C	2.5 V		2		pF
Bandwidth	BW	$R_L = 50\ \Omega$ ,	Switch ON, See <a href="#">Figure 18</a>	25°C	2.5 V		150		MHz
OFF isolation	$O_{ISO}$	$R_L = 50\ \Omega$ , $f = 1\ \text{MHz}$ ,	Switch OFF, See <a href="#">Figure 19</a>	25°C	2.5 V		-62		dB
Total harmonic distortion	THD	$R_L = 600\ \Omega$ , $C_L = 50\ \text{pF}$ ,	$f = 20\ \text{Hz}$ to $20\ \text{kHz}$ , See <a href="#">Figure 21</a>	25°C	2.5 V		0.02%		
<b>Supply</b>									
Positive supply current	$I_{CC}$	$V_I = V_{CC}$ or GND,	Switch ON or OFF	25°C	2.7 V	0.001	0.02	μA	
				Full			0.25		

(1) The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum.

## 6.11 Electrical Characteristics for 1.8-V Supply<sup>(1)</sup>

$V_{CC} = 1.65 \text{ V}$  to  $1.95 \text{ V}$ ,  $T_A = -40^\circ\text{C}$  to  $85^\circ\text{C}$  (unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITIONS		$T_A$	$V_{CC}$	MIN	TYP	MAX	UNIT
<b>Analog Switch</b>									
Peak ON resistance	$r_{peak}$	$0 \leq V_{NC} \leq V_{CC}$ , $I_{COM} = -100 \text{ mA}$ ,	Switch ON, See <a href="#">Figure 13</a>	25°C	1.65 V	4.2	25	$\Omega$	
				Full		30			
ON-state resistance	$r_{on}$	$V_{NC} = 2 \text{ V}$ , $I_{COM} = -100 \text{ mA}$ ,	Switch ON, See <a href="#">Figure 13</a>	25°C	1.65 V	1.6	3.9	$\Omega$	
				Full		4.0			
ON-state resistance flatness	$r_{on(flat)}$	$0 \leq V_{NC} \leq V_{CC}$ , $I_{COM} = -100 \text{ mA}$ ,	Switch ON, See <a href="#">Figure 13</a>	25°C	1.65 V	2.8		$\Omega$	
		$V_{NC} = 2 \text{ V}, 0.8 \text{ V}$ , $I_{COM} = -100 \text{ mA}$ ,		25°C		4.1	22		
		Full		Full		27			
NC OFF leakage current	$I_{NC(OFF)}$	$V_{NC} = 1 \text{ V}$ , $V_{COM} = 3 \text{ V}$ , or $V_{NC} = 3 \text{ V}$ , $V_{COM} = 1 \text{ V}$ ,	Switch OFF, See <a href="#">Figure 14</a>	25°C	1.95 V	-5	5	$nA$	
		Full		Full		-50	50		
	$I_{NC(PWROFF)}$	$V_{NC} = 0$ to $3.6 \text{ V}$ , $V_{COM} = 3.6 \text{ V}$ to $0$ ,		25°C	0 V	-2	2	$\mu A$	
		Full		Full		-10	10		
COM OFF leakage current	$I_{COM(OFF)}$	$V_{COM} = 1 \text{ V}$ , $V_{NC} = 3 \text{ V}$ , or $V_{COM} = 3 \text{ V}$ , $V_{NC} = 1 \text{ V}$ ,	Switch OFF, See <a href="#">Figure 14</a>	25°C	1.95 V	-5	5	$nA$	
		Full		Full		-50	50		
	$I_{COM(PWROFF)}$	$V_{COM} = 0$ to $3.6 \text{ V}$ , $V_{NC} = 3.6 \text{ V}$ to $0$ ,		25°C	0 V	-2	2	$\mu A$	
		Full		Full		-10	10		
NC ON leakage current	$I_{NC(ON)}$	$V_{NC} = 1 \text{ V}$ , $V_{COM} = \text{Open}$ , or $V_{NC} = 3 \text{ V}$ , $V_{COM} = \text{Open}$ ,	Switch ON, See <a href="#">Figure 15</a>	25°C	1.95 V	-2	2	$nA$	
				Full		-20	20		
COM ON leakage current	$I_{COM(ON)}$	$V_{COM} = 1 \text{ V}$ , $V_{NC} = \text{Open}$ , or $V_{COM} = 3 \text{ V}$ , $V_{NC} = \text{Open}$ ,	Switch ON, See <a href="#">Figure 15</a>	25°C	1.95 V	-2	2	$nA$	
				Full		-20	20		
<b>Digital Control Inputs (IN)</b>									
Input logic high	$V_{IH}$			Full		1.5	5.5	$V$	
Input logic low	$V_{IL}$			Full		0	0.6	$V$	
Input leakage current	$I_{IH}, I_{IL}$	$V_I = 5.5 \text{ V}$ or $0$	Switch ON, See <a href="#">Figure 15</a>	25°C	1.95 V	-2	0.3	2	$nA$
				Full		-20	20		

(1) The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum.

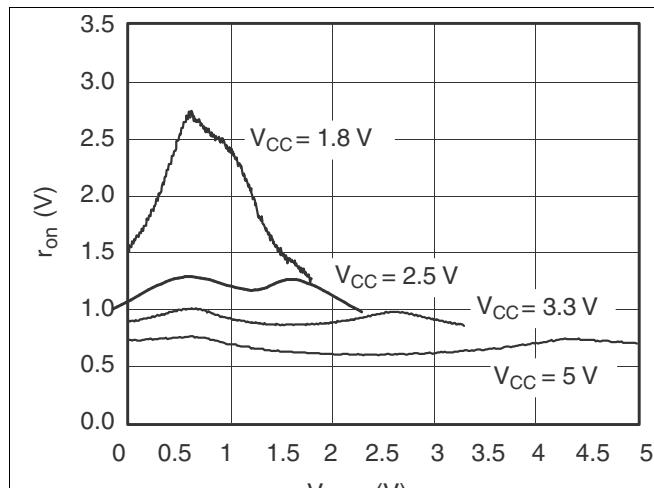
## 6.12 Electrical Characteristics for 1.8-V Supply<sup>(1)</sup> (continued)

$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$ ,  $T_A = -40^\circ\text{C}$  to  $85^\circ\text{C}$  (unless otherwise noted)

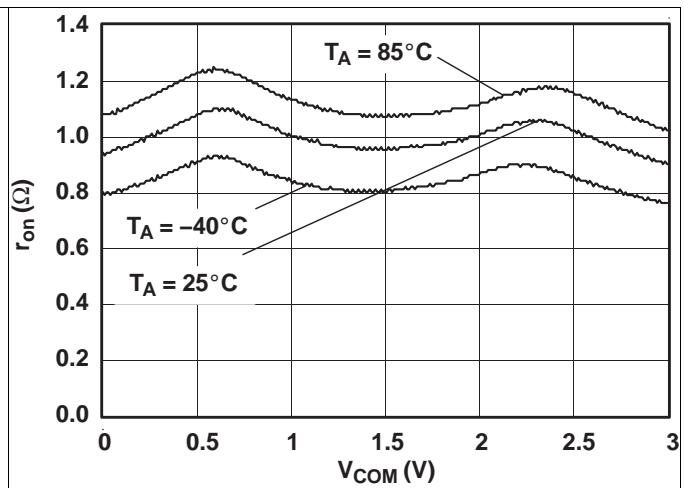
PARAMETER	SYMBOL	TEST CONDITIONS	$T_A$	$V_{CC}$	MIN	TYP	MAX	UNIT
<b>Dynamic</b>								
Turn-on time	$t_{ON}$	$V_{COM} = V_{CC}$ , $R_L = 50 \Omega$ ,	$C_L = 35 \text{ pF}$ , See <a href="#">Figure 17</a>	25°C	1.8 V	3	9	18
				Full	1.65 V to 1.95 V	1	20	ns
Turn-off time	$t_{OFF}$	$V_{COM} = V_{CC}$ , $R_L = 50 \Omega$ ,	$C_L = 35 \text{ pF}$ , See <a href="#">Figure 17</a>	25°C	1.8 V	5	10	15.5
				Full	1.65 V to 1.95 V	4	18.5	ns
Charge injection	$Q_C$	$V_{GEN} = 0$ , $R_{GEN} = 0$ ,	$C_L = 1 \text{ nF}$ , See <a href="#">Figure 20</a>	25°C	1.8 V	2		pC
NC OFF capacitance	$C_{NC(OFF)}$	$V_{NC} = V_{CC}$ or GND,	Switch OFF, See <a href="#">Figure 16</a>	25°C	1.8 V	19.5		pF
COM OFF capacitance	$C_{COM(OFF)}$	$V_{COM} = V_{CC}$ or GND,	Switch OFF, See <a href="#">Figure 16</a>	25°C	1.8 V	18.5		pF
NC ON capacitance	$C_{NC(ON)}$	$V_{NC} = V_{CC}$ or GND,	Switch ON, See <a href="#">Figure 16</a>	25°C	1.8 V	36.5		pF
COM ON capacitance	$C_{COM(ON)}$	$V_{COM} = V_{CC}$ or GND,	Switch ON, See <a href="#">Figure 16</a>	25°C	1.8 V	36.5		pF
Digital input capacitance	$C_I$	$V_I = V_{CC}$ or GND,	See <a href="#">Figure 16</a>	25°C	1.8 V	2		pF
Bandwidth	BW	$R_L = 50 \Omega$ ,	Switch ON, See <a href="#">Figure 18</a>	25°C	1.8 V	150		MHz
OFF isolation	$O_{ISO}$	$R_L = 50 \Omega$ , $f = 1 \text{ MHz}$ ,	Switch OFF, See <a href="#">Figure 19</a>	25°C	1.8 V	–62		dB
Total harmonic distortion	THD	$R_L = 600 \Omega$ , $C_L = 50 \text{ pF}$ ,	$f = 20 \text{ Hz to } 20 \text{ kHz}$ See <a href="#">Figure 21</a>	25°C	1.8 V	0.055%		
<b>Supply</b>								
Positive supply current	$I_{CC}$	$V_I = V_{CC}$ or GND,	Switch ON or OFF	25°C	1.95 V	0.001	0.01	$\mu\text{A}$
				Full		0.15		

(1) The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum.

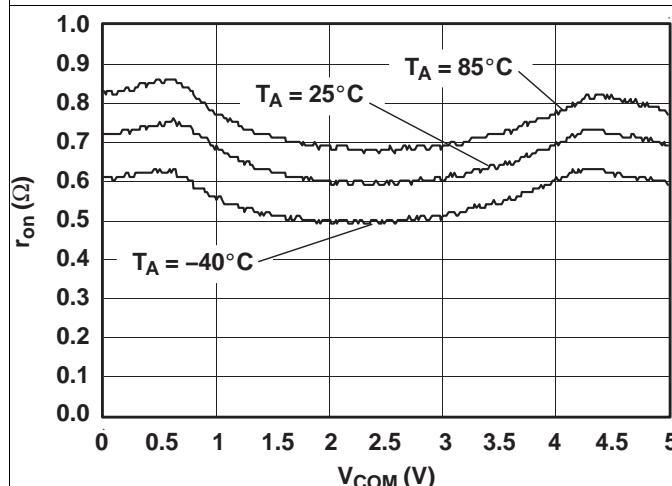
## 6.13 Typical Performance



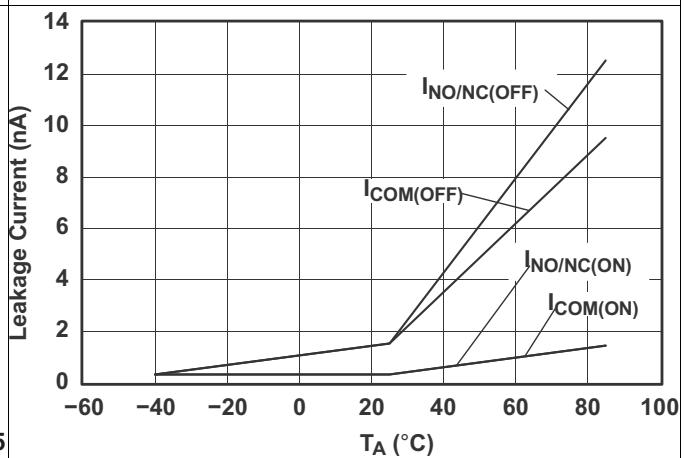
**Figure 1.**  $r_{on}$  vs  $V_{COM}$



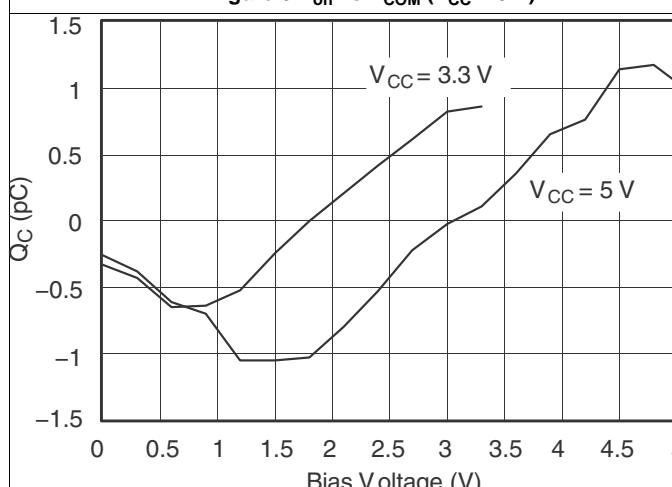
**Figure 2.**  $r_{on}$  vs  $V_{COM}$  ( $V_{CC} = 3\text{ V}$ )



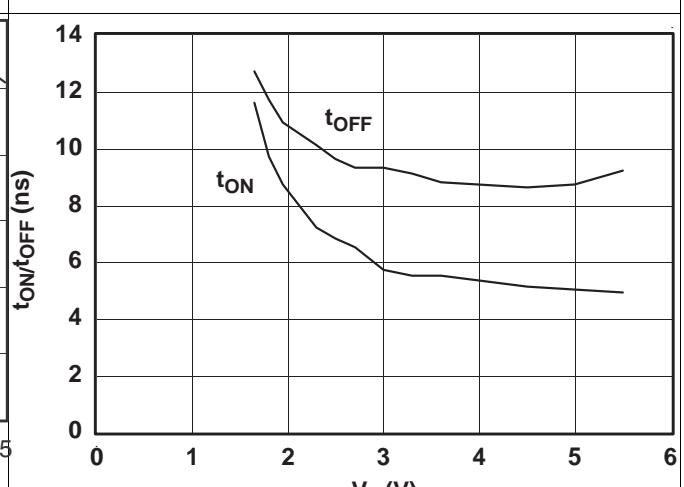
**Figure 3.**  $r_{on}$  vs  $V_{COM}$  ( $V_{CC} = 5\text{ V}$ )



**Figure 4.** Leakage Current vs Temperature ( $V_{CC} = 5.5\text{ V}$ )

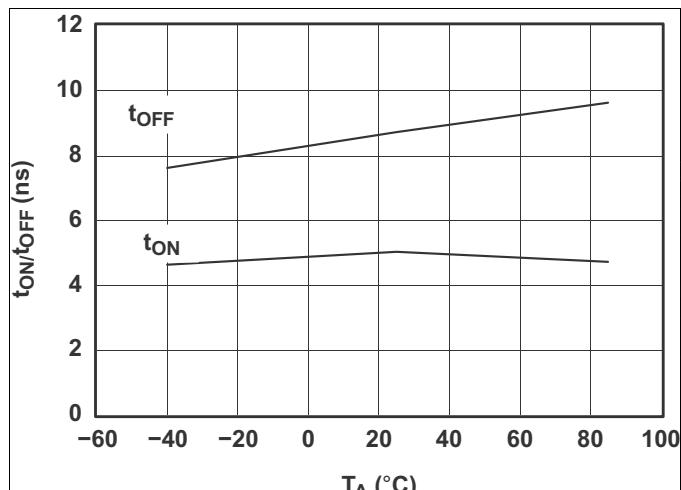
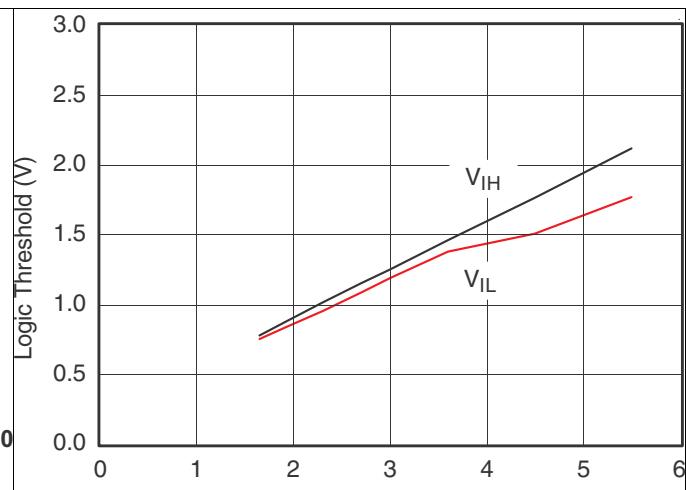
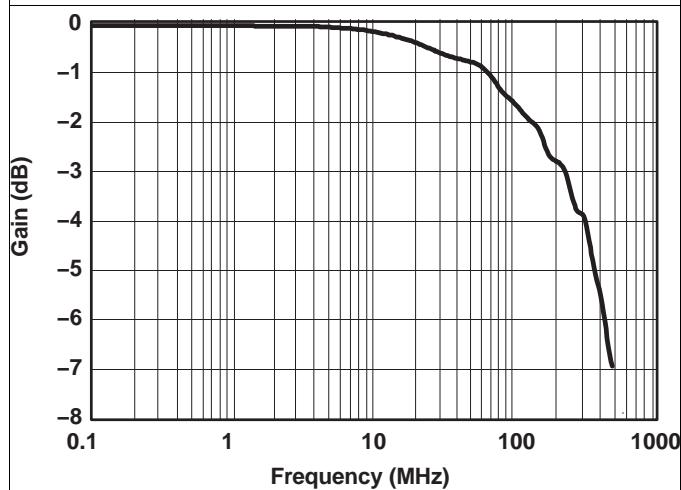
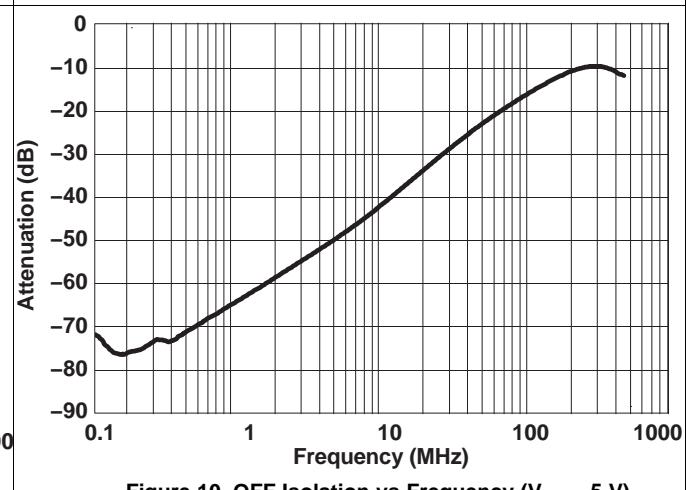
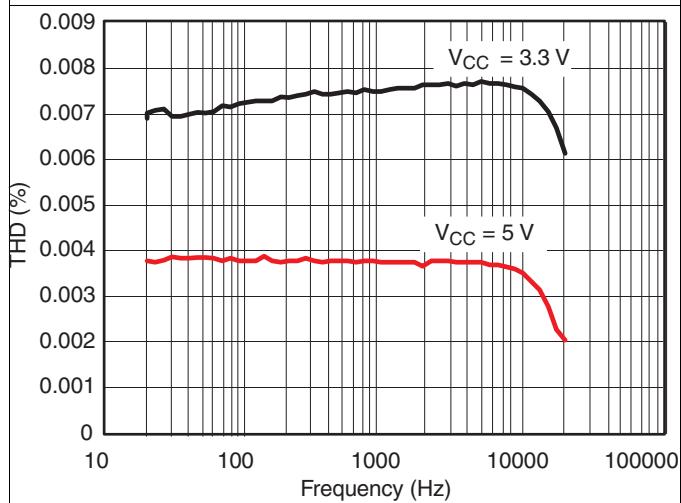
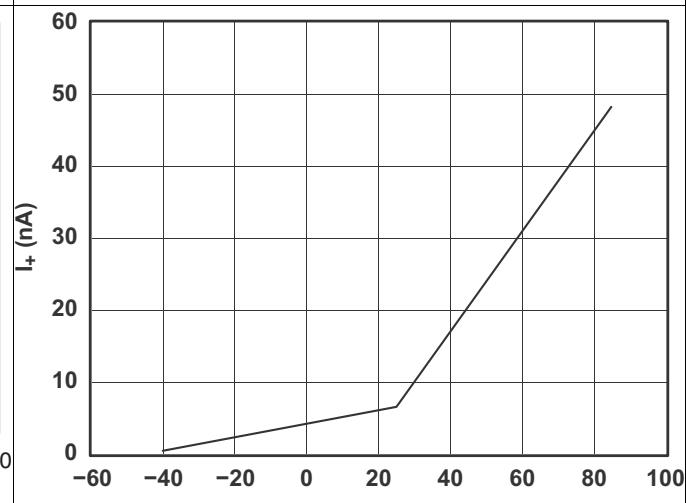


**Figure 5.** Charge Injection ( $Q_C$ ) vs  $V_{COM}$

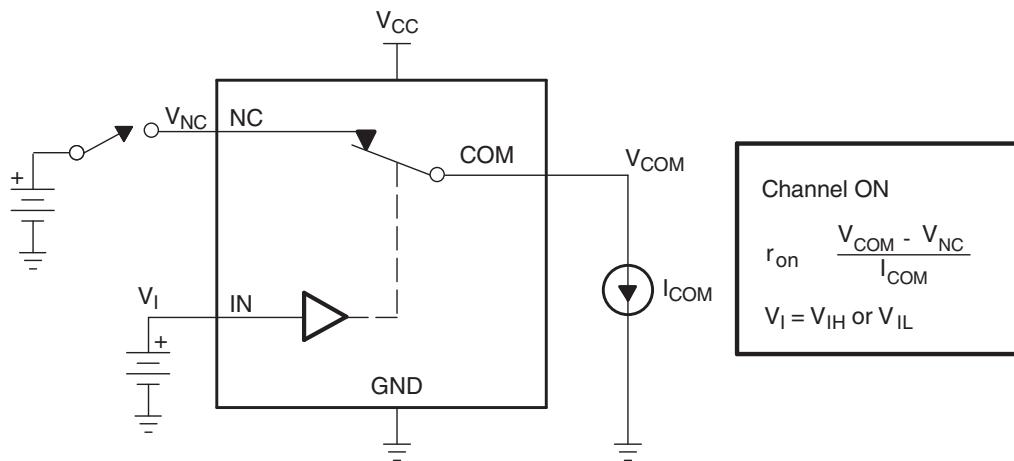


**Figure 6.**  $t_{ON}$  and  $t_{OFF}$  vs Supply Voltage

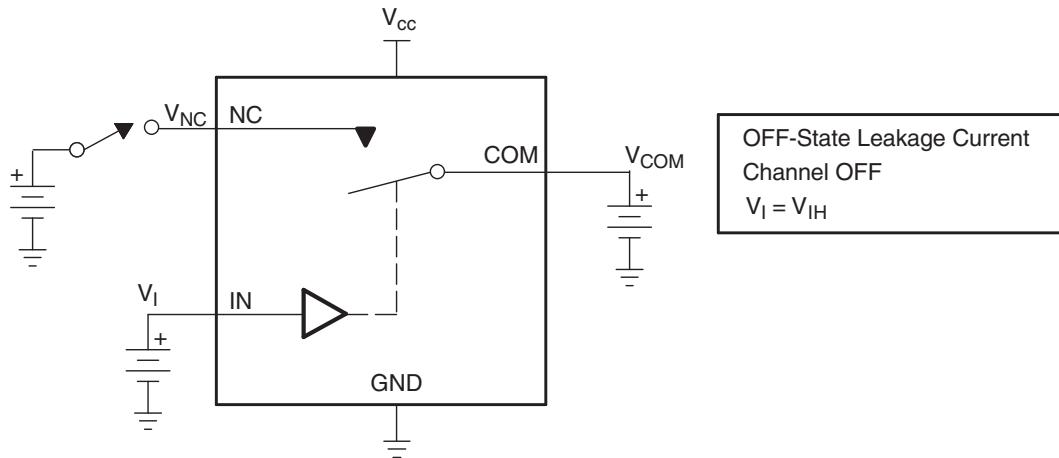
## Typical Performance (continued)

Figure 7.  $t_{ON}$  and  $t_{OFF}$  vs Temperature ( $V_{CC} = 5$  V)Figure 8. Logic Threshold vs  $V_{CC}$ Figure 9. Gain vs Frequency ( $V_{CC} = 5$  V)Figure 10. OFF Isolation vs Frequency ( $V_{CC} = 5$  V)Figure 11. Total Harmonic Distortion vs Frequency  
( $V_{CC} = 5$  V)Figure 12. Power-Supply Current vs Temperature  
( $V_{CC} = 5$  V)

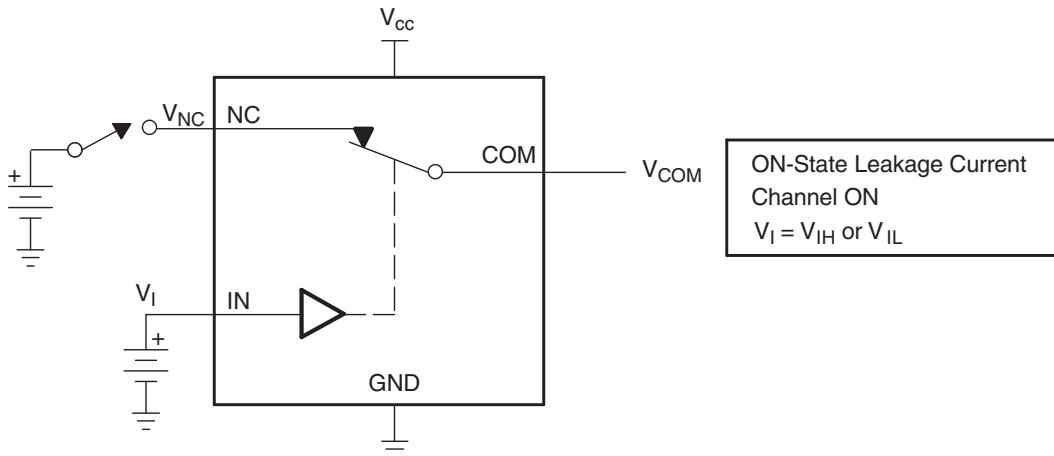
## 7 Parameter Measurement Information



**Figure 13. ON-State Resistance ( $r_{on}$ )**

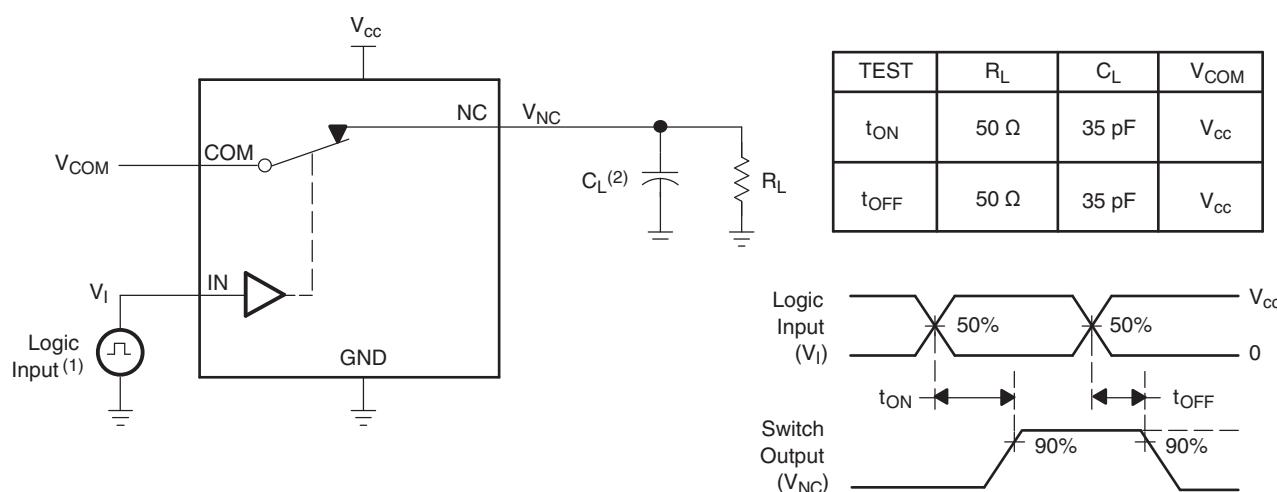
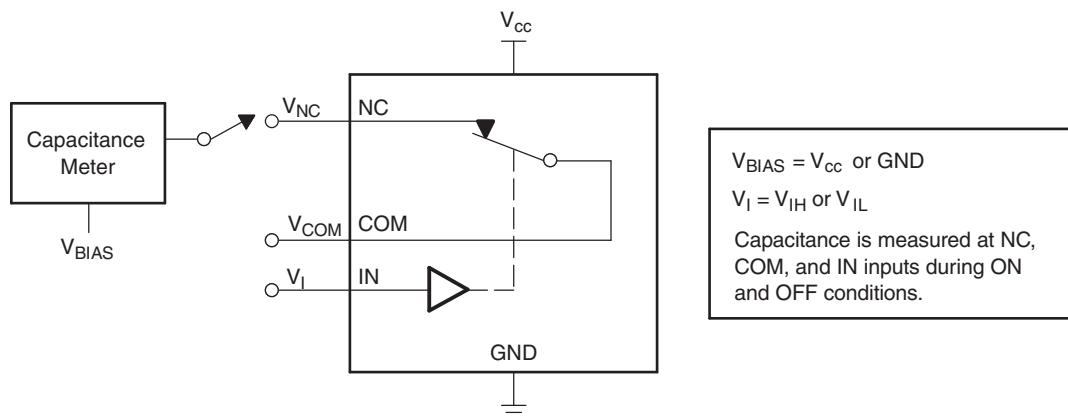


**Figure 14. OFF-State Leakage Current ( $I_{COM(OFF)}$ ,  $I_{NC(OFF)}$ ,  $I_{COM(PWROFF)}$ ,  $I_{NC(PWROFF)}$ )**



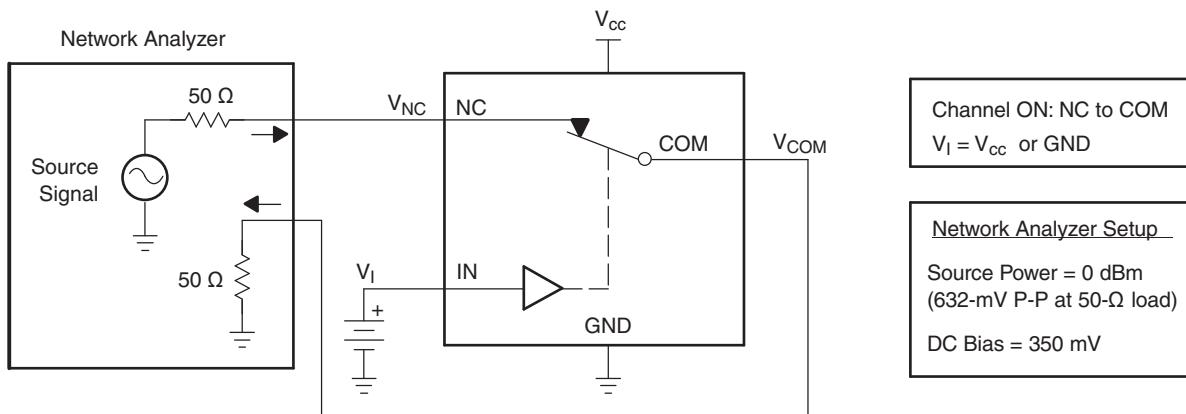
**Figure 15. ON-State Leakage Current ( $I_{COM(ON)}$ ,  $I_{NC(ON)}$ )**

### Parameter Measurement Information (continued)



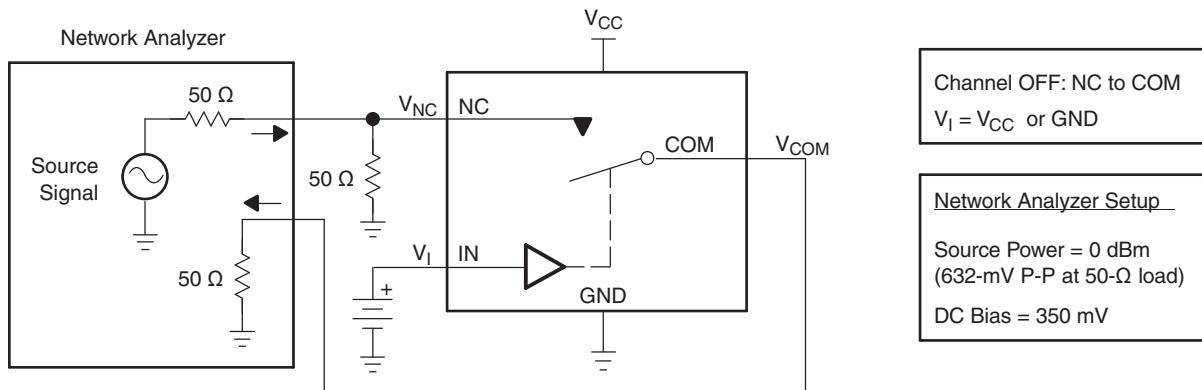
- (1) All input pulses are supplied by generators having the following characteristics: PRR ≤ 10 MHz, Z<sub>O</sub> = 50 Ω, t<sub>r</sub> < 5 ns, t<sub>f</sub> < 5 ns.
- (2) C<sub>L</sub> includes probe and jig capacitance.

**Figure 17. Turn-On (t<sub>ON</sub>) and Turn-Off Time (t<sub>OFF</sub>)**

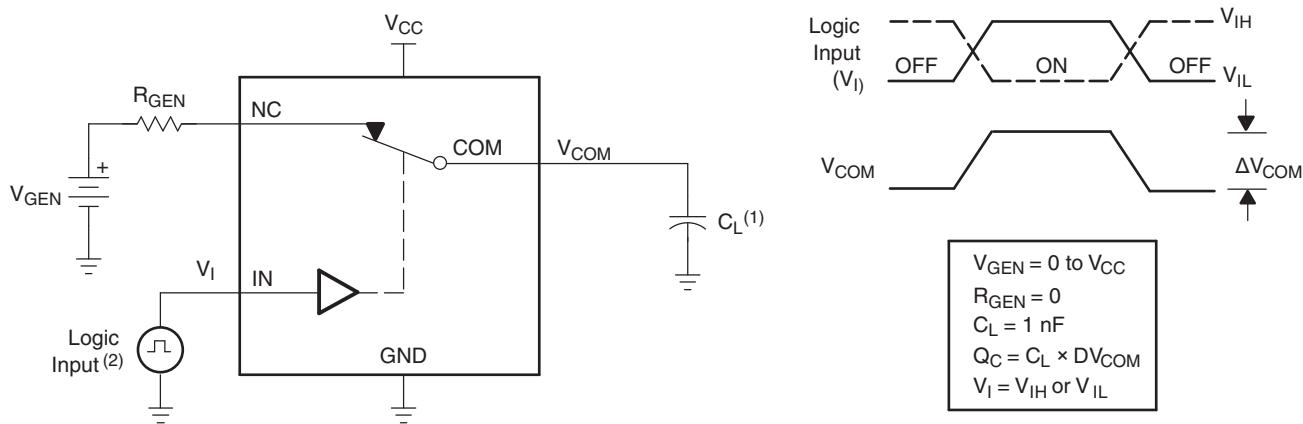


**Figure 18. Bandwidth (BW)**

### Parameter Measurement Information (continued)

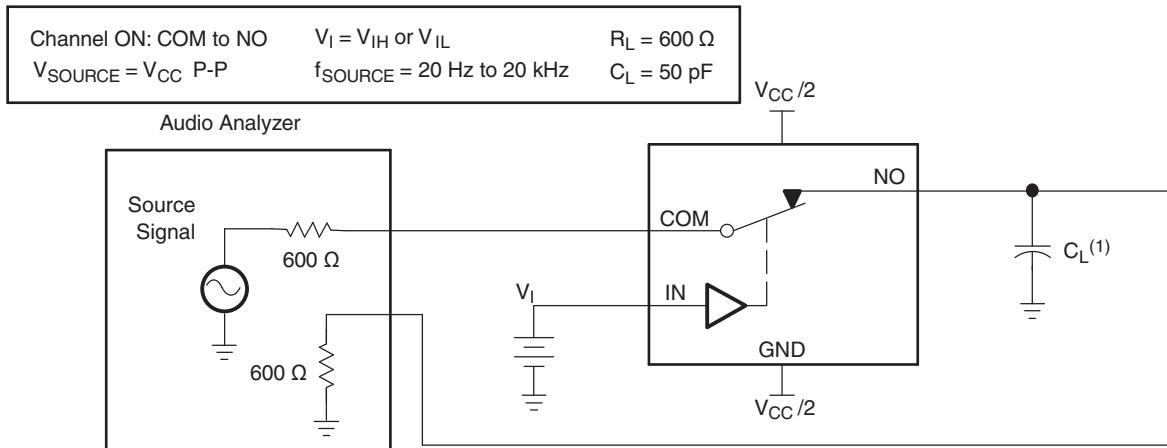


**Figure 19. OFF Isolation ( $O_{ISO}$ )**



- (1) C<sub>L</sub> includes probe and jig capacitance.
- (2) All input pulses are supplied by generators having the following characteristics: PRR ≤ 10 MHz, Z<sub>O</sub> = 50 Ω, t<sub>r</sub> < 5 ns, t<sub>f</sub> < 5 ns.

**Figure 20. Charge Injection (Q<sub>c</sub>)**



- (1) C<sub>L</sub> includes probe and jig capacitance.

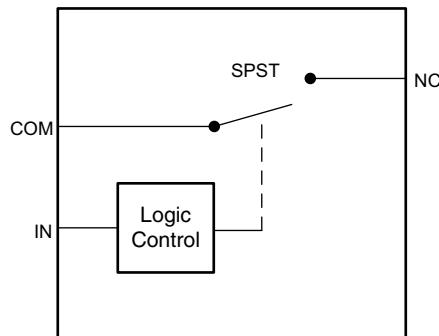
**Figure 21. Total Harmonic Distortion (THD)**

## 8 Detailed Description

### 8.1 Overview

The TS5A3167 is a bidirectional, single-channel, single-pole single-throw (SPST) analog switch that is designed to operate from 1.65 V to 5.5 V. This device provides a signal switching solution while maintaining excellent signal integrity, which makes the TS5A3367 suitable for a wide range of applications in various markets including personal electronics, portable instrumentation, and test and measurement equipment. The device maintains the signal integrity by its low ON-state resistance, excellent ON-state resistance matching, and total harmonic distortion (THD) performance. The device consumes very low power and provides isolation when  $V_{CC} = 0$ .

### 8.2 Functional Block Diagram



### 8.3 Feature Description

#### 8.3.1 Isolation in Powered-Off Mode, $V_{CC} = 0$

When power is not supplied to the  $V_{CC}$  pin,  $V_{CC} = 0$ , the signal paths NC and COM are high impedance. This is specified in the electrical characteristics table under the COM and NC OFF leakage current when  $V_{CC} = 0$ . Because the device is high impedance when it is not powered, you may connect other signals to the signal chain without interference of the TS5A3167.

### 8.4 Device Functional Modes

Placing a logic low signal on the IN pin of the device will turn on the switch and provide a low impedance path from NC to COM.

**Table 1. Function Table**

IN	NC TO COM, COM TO NC
L	ON
H	OFF

## 9 Application and Implementation

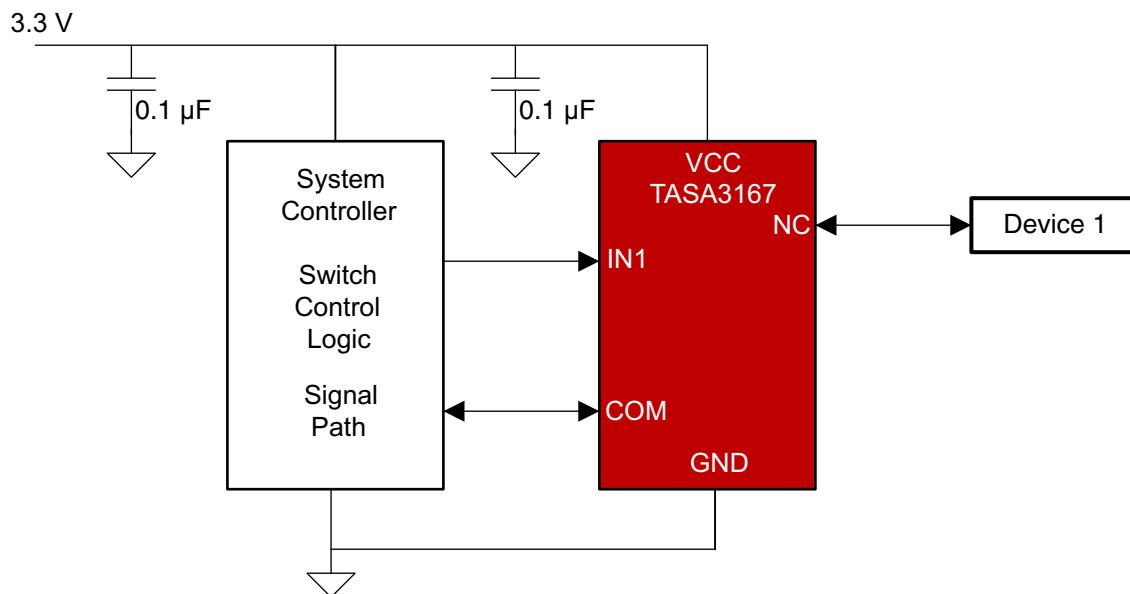
### NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

### 9.1 Application Information

The TS5A3167 switch is bidirectional, so the NC and COM pins can be used as either inputs or outputs. This switch is typically used when there is one signal path that needs to be isolated at certain times.

### 9.2 Typical Application



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Figure 22. Typical Application

#### 9.2.1 Design Requirements

The TS5A3167 device can be properly operated without any external components.

Unused pin may be left floating or connected to ground.

TI recommends pulling up the digital control pin (IN) to  $V_{CC}$  or pulling down to GND to avoid undesired switch positions that could result from the floating pin. A floating digital pin could cause excess current consumption refer to [Implications of Slow or Floating CMOS Inputs](#).

#### 9.2.2 Detailed Design Procedure

Select the appropriate supply voltage to cover the entire voltage swing of the signal passing through the switch because the TS5A3167 input and output signal swing through NC and COM are dependent on the supply voltage  $V_{CC}$ . For example, if the desired signal level to pass through the switch is 5 V,  $V_{CC}$  must be greater than or equal to 5 V.  $V_{CC} = 3.3$  V would not be valid for passing a 5-V signal since the analog signal voltage cannot exceed the supply.

## Typical Application (continued)

### 9.2.3 Application Curves

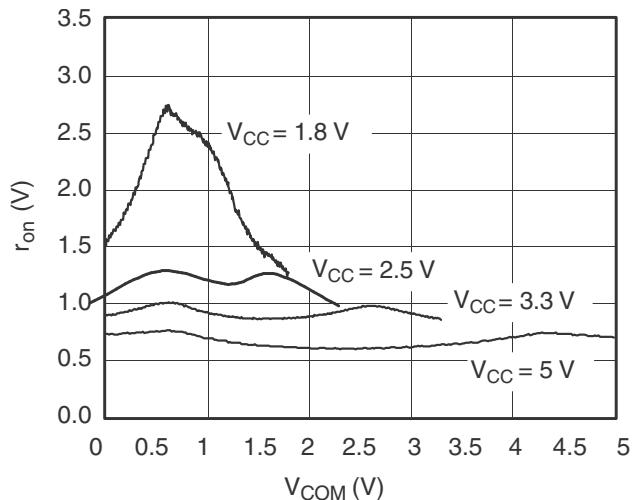


Figure 23.  $r_{on}$  vs  $V_{COM}$

## 10 Power Supply Recommendations

TI recommends proper power-supply sequencing for all CMOS devices. Do not exceed the absolute maximum ratings, because stresses beyond the listed ratings can cause permanent damage to the device. It is recommended that  $V_{CC}$  is powered on first, followed by NC or COM but not required because of the Isolation in Powered-Off Mode,  $V_{CC} = 0$  feature.

Although it is not required, power-supply bypassing improves noise margin and prevents switching noise propagation from the  $V_{CC}$  supply to other components. A 0.1- $\mu\text{F}$  capacitor, connected from  $V_{CC}$  to GND, is adequate for most applications.

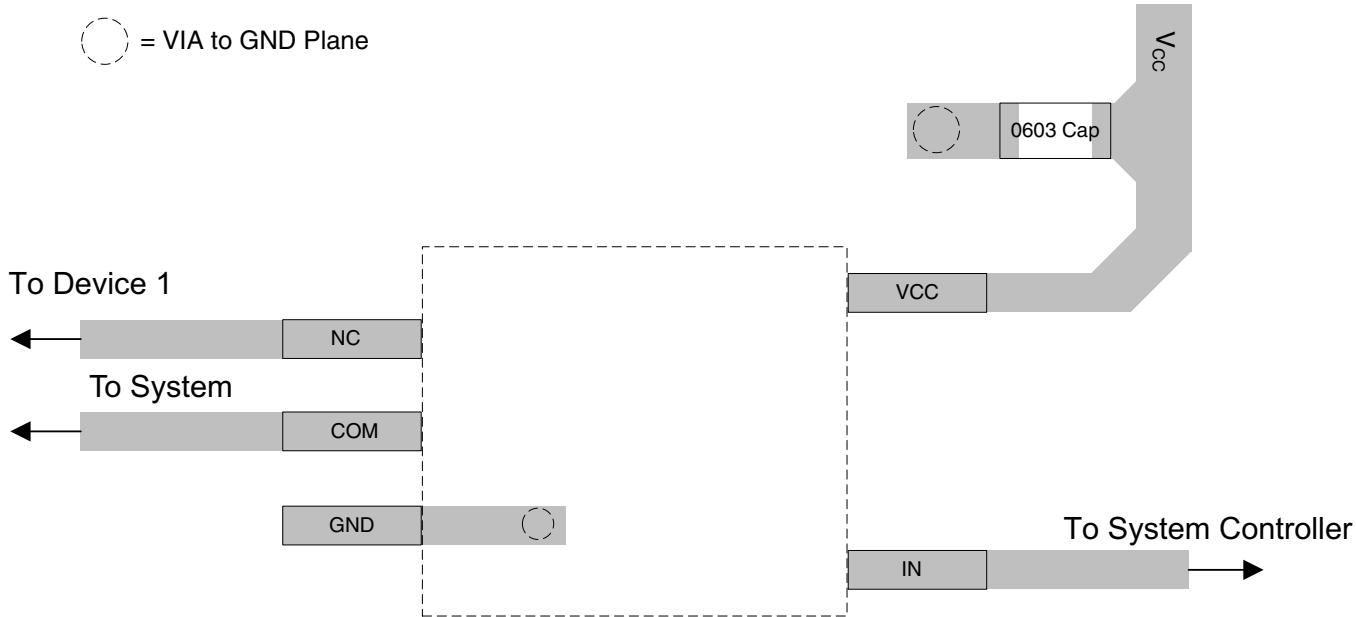
## 11 Layout

### 11.1 Layout Guidelines

TI recommends following common printed-circuit board layout guidelines to ensure reliability of the device.

- Bypass capacitors should be used on power supplies.
- Short trace lengths should be used to avoid excessive loading.

### 11.2 Layout Example



**Figure 24. Example Layout**

## 12 デバイスおよびドキュメントのサポート

### 12.1 ドキュメントのサポート

表 2. パラメータの説明

記号	説明
$V_{COM}$	COM電圧。
$V_{NC}$	NC電圧。
$r_{on}$	チャネルがオンのときのCOMとNOポート間の抵抗
$r_{peak}$	規定電圧範囲内でのピーク・オン抵抗
$r_{on(Flat)}$	規定の条件の範囲における、チャネルの $r_{on}$ の最大値と最小値との差。
$I_{NC(OFF)}$	対応チャネル(NCからCOM)がオフ状態のとき、NCポートで測定されるリーク電流、ワーストケースの入力および出力条件
$I_{NC(PWROFF)}$	パワーダウン状況、 $V_{CC} = 0$ のとき、NCポートで測定されるリーク電流
$I_{COM(OFF)}$	ワーストケースの入力および出力条件で、対応チャネル(COMからNC)がオフ状態のとき、COMポートで測定されるリーク電流
$I_{COM(PWROFF)}$	パワーダウン状況、 $V_{CC} = 0$ のとき、COMポートで測定されるリーク電流
$I_{NC(ON)}$	対応チャネル(NCからCOM)がオン状態、出力(COM)がオープンのとき、NCポートで測定されるリーク電流
$I_{COM(ON)}$	対応チャネル(COMからNC)がオン状態、出力(NC)がオープンのとき、COMポートで測定されるリーク電流
$V_{IH}$	制御入力(IN)の論理HIGHの最小入力電圧。
$V_{IL}$	制御入力(IN)の論理LOWの最大入力電圧。
$V_I$	制御入力(IN)の電圧。
$I_{IH}, I_{IL}$	制御入力(IN)で測定されるリーク電流。
$t_{ON}$	スイッチのターンオン時間。このパラメータは、規定された条件の範囲で、スイッチがオンになるとときのデジタル制御(IN)信号とアナログ出力(COM, NC)信号との間の伝搬遅延により測定されます。
$t_{OFF}$	スイッチのターンオフ時間。このパラメータは、規定された条件の範囲で、スイッチがオフになるとときのデジタル制御(IN)信号とアナログ出力(COM, NC)信号との間の伝搬遅延により測定されます。
$Q_C$	電荷注入は、制御(IN)入力からアナログ(NC, COM)出力への、望ましくない信号のカップリングの測定値です。この値はクーロン(C)単位で、制御入力のスイッチングによって誘導される合計電荷により測定されます。電荷注入 $Q_C = C_L \times \Delta V_{COM}$ で、 $C_L$ は負荷容量、 $\Delta V_{COM}$ はアナログ出力電圧の変化です。
$C_{NC(OFF)}$	対応チャネル(NCからCOM)がオフのときのNCポートの容量。
$C_{COM(OFF)}$	対応チャネル(COMからNC)がオフのときのCOMポートの容量。
$C_{NC(ON)}$	対応チャネル(NCからCOM)がオンのときのNCポートの容量。
$C_{COM(ON)}$	対応チャネル(COMからNC)がオンのときのCOMポートの容量。
$C_I$	制御入力(IN)の容量。
$O_{ISO}$	スイッチのオフ絶縁は、オフ状態のスイッチのインピーダンス測定値です。これは、対応チャネル(NCからCOM)がオフ状態のとき、特定の周波数についてdB単位で測定されます。
$BW$	スイッチの帯域幅。オン状態のチャネルのゲインがDCゲインより-3dB低くなる周波数です。
$THD$	全高調波歪は、アナログ・スイッチにより発生する信号の歪みです。この値は、2次、3次、およびさらに高次の高調波の二乗平均(RMS)値と、基本波の絶対振幅との比として定義されます。
$I_{cc}$	制御(IN)ピンが $V_{CC}$ またはGNDであるときの静的消費電流

### 12.2 ドキュメントの更新通知を受け取る方法

ドキュメントの更新についての通知を受け取るには、ti.comのデバイス製品フォルダを開いてください。右上の隅にある「通知を受け取る」をクリックして登録すると、変更されたすべての製品情報に関するダイジェストを毎週受け取れます。変更の詳細については、修正されたドキュメントに含まれている改訂履歴をご覧ください。

### 12.3 コミュニティ・リソース

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

**TI E2E™オンライン・コミュニティ** TIのE2E (*Engineer-to-Engineer*) コミュニティ。エンジニア間の共同作業を促進するために開設されたものです。e2e.ti.comでは、他のエンジニアに質問し、知識を共有

## コミュニティ・リソース (continued)

し、アイディアを検討して、問題解決に役立てることができます。

**設計サポート** TIの設計サポート 役に立つE2Eフォーラムや、設計サポート・ツールをすばやく見つけることができます。技術サポート用の連絡先情報も参照できます。

## 12.4 商標

E2E is a trademark of Texas Instruments.

## 12.5 静電気放電に関する注意事項

すべての集積回路は、適切なESD保護方法を用いて、取扱いと保存を行うようにして下さい。

 静電気放電はわずかな性能の低下から完全なデバイスの故障に至るまで、様々な損傷を与えます。高精度の集積回路は、損傷に対して敏感であり、極めてわずかなパラメータの変化により、デバイスに規定された仕様に適合しなくなる場合があります。

## 12.6 Glossary

[SLYZ022 — TI Glossary](#).

This glossary lists and explains terms, acronyms, and definitions.

## 13 メカニカル、パッケージ、および注文情報

以降のページには、メカニカル、パッケージ、および注文に関する情報が記載されています。この情報は、そのデバイスについて利用可能な最新のデータです。このデータは予告なく変更されることがあり、ドキュメントが改訂される場合もあります。本データシートのブラウザ版を使用されている場合は、画面左側の説明をご覧ください。

**PACKAGING INFORMATION**

Orderable part number	Status (1)	Material type (2)	Package   Pins	Package qty   Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
TS5A3167DBVR	Active	Production	SOT-23 (DBV)   5	3000   LARGE T&R	Yes	NIPDAU   SN	Level-1-260C-UNLIM	-40 to 85	(JATF, JATR) (JATH, JATP)
TS5A3167DBVR.B	Active	Production	SOT-23 (DBV)   5	3000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	(JATF, JATR) (JATH, JATP)
TS5A3167DCKR	Active	Production	SC70 (DCK)   5	3000   LARGE T&R	Yes	NIPDAU   NIPDAU	Level-1-260C-UNLIM	-40 to 85	(JG5, JGF, JGR) (JGH, JGP, JGS)
TS5A3167DCKR.B	Active	Production	SC70 (DCK)   5	3000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	(JG5, JGF, JGR) (JGH, JGP, JGS)
TS5A3167DCKRG4	Active	Production	SC70 (DCK)   5	3000   LARGE T&R	Yes	NIPDAU   NIPDAU	Level-1-260C-UNLIM	-40 to 85	(JG5, JGF, JGR) (JGH, JGP, JGS)
TS5A3167DCKRG4.B	Active	Production	SC70 (DCK)   5	3000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	(JG5, JGF, JGR) (JGH, JGP, JGS)
TS5A3167YZPR	Active	Production	DSBGA (YZP)   5	3000   LARGE T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 85	JGN
TS5A3167YZPR.B	Active	Production	DSBGA (YZP)   5	3000   LARGE T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 85	JGN

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

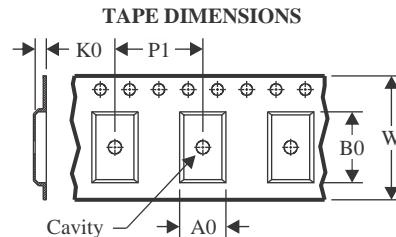
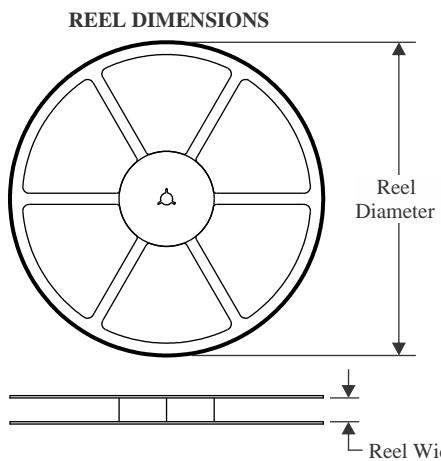
<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

**Important Information and Disclaimer:** The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

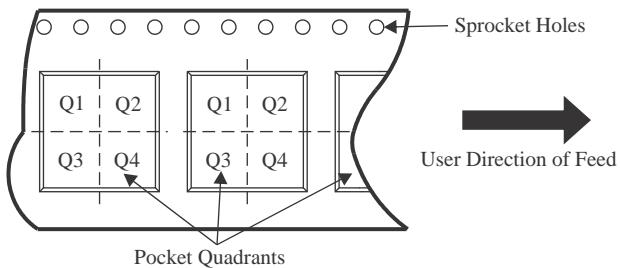
In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

## TAPE AND REEL INFORMATION



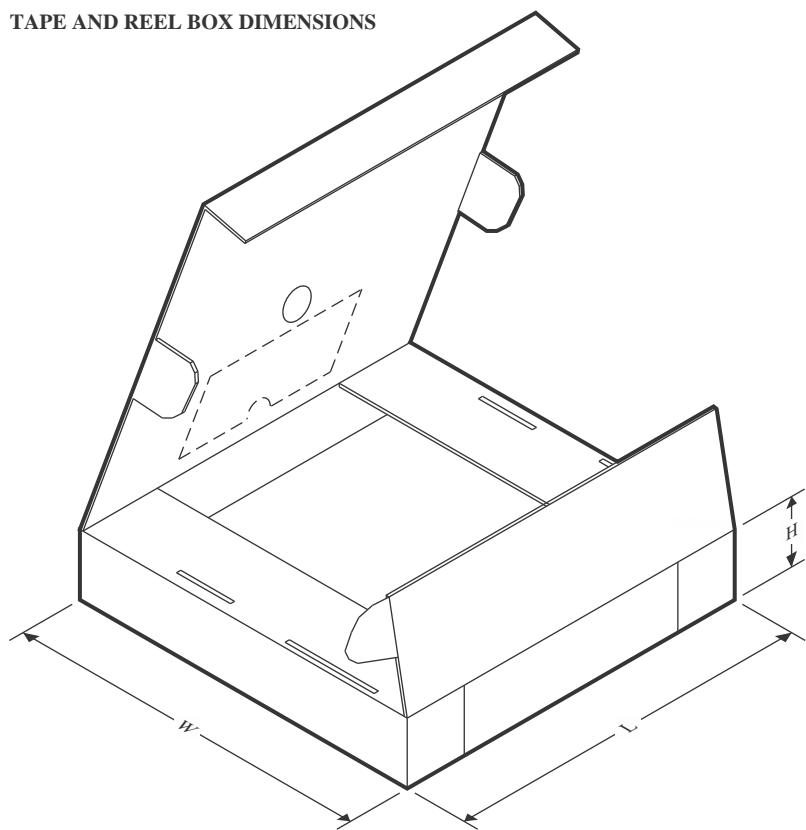
A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TS5A3167DBVR	SOT-23	DBV	5	3000	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
TS5A3167DCKR	SC70	DCK	5	3000	180.0	8.4	2.47	2.3	1.25	4.0	8.0	Q3
TS5A3167DCKRG4	SC70	DCK	5	3000	180.0	8.4	2.47	2.3	1.25	4.0	8.0	Q3
TS5A3167YZPR	DSBGA	YZP	5	3000	178.0	9.2	1.02	1.52	0.63	4.0	8.0	Q1

**TAPE AND REEL BOX DIMENSIONS**


\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TS5A3167DBVR	SOT-23	DBV	5	3000	180.0	180.0	18.0
TS5A3167DCKR	SC70	DCK	5	3000	202.0	201.0	28.0
TS5A3167DCKRG4	SC70	DCK	5	3000	202.0	201.0	28.0
TS5A3167YZPR	DSBGA	YZP	5	3000	220.0	220.0	35.0

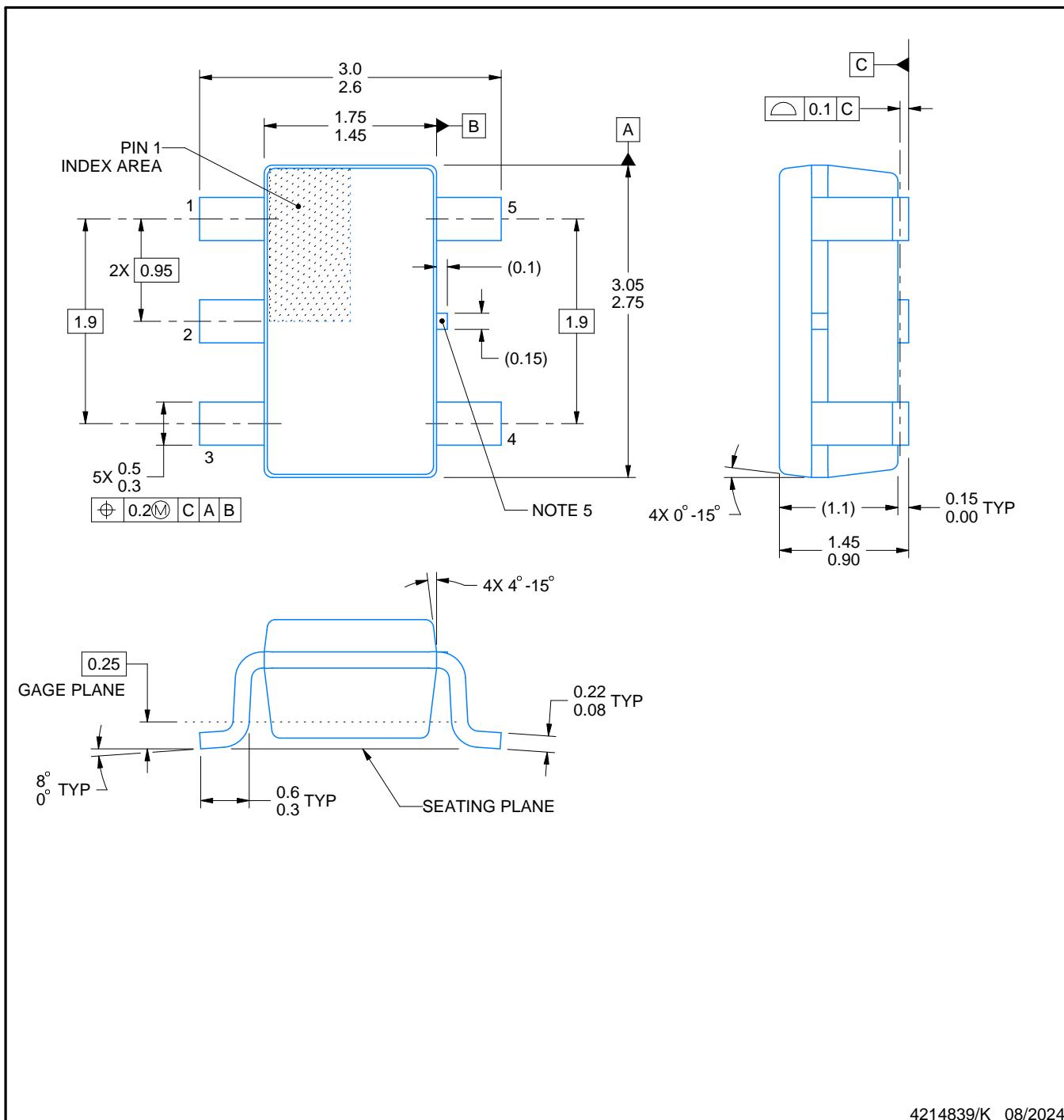
# PACKAGE OUTLINE

**DBV0005A**



**SOT-23 - 1.45 mm max height**

SMALL OUTLINE TRANSISTOR



4214839/K 08/2024

## NOTES:

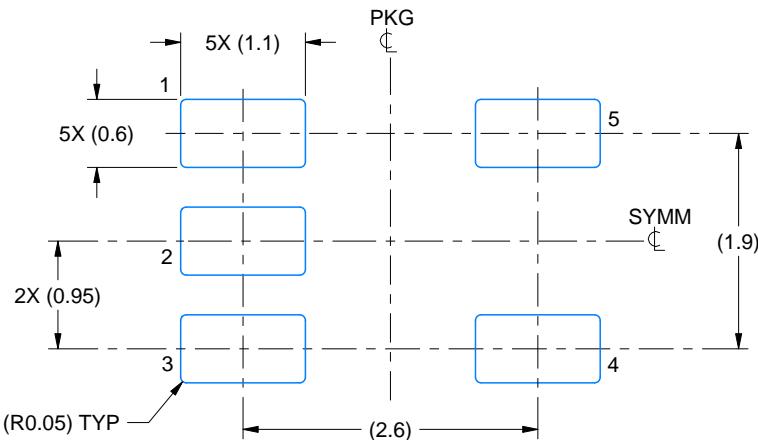
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. Reference JEDEC MO-178.
4. Body dimensions do not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.25 mm per side.
5. Support pin may differ or may not be present.

# EXAMPLE BOARD LAYOUT

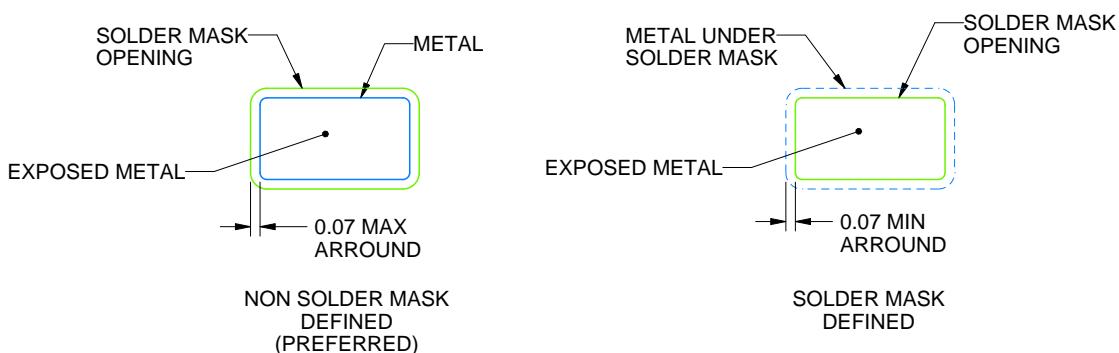
DBV0005A

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE:15X



SOLDER MASK DETAILS

4214839/K 08/2024

NOTES: (continued)

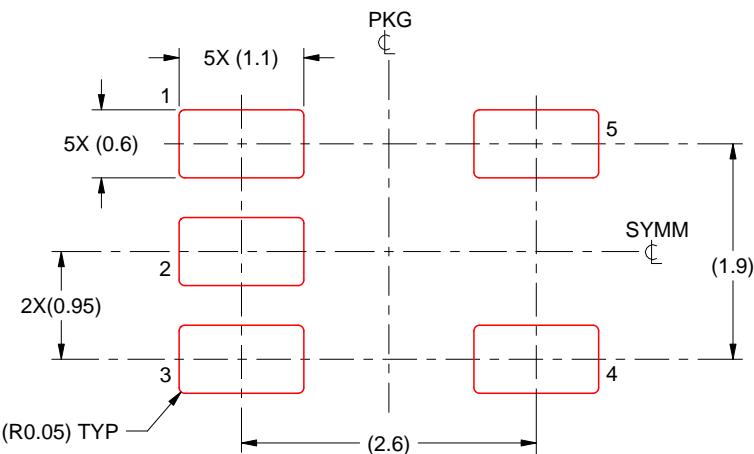
6. Publication IPC-7351 may have alternate designs.
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

# EXAMPLE STENCIL DESIGN

DBV0005A

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE:15X

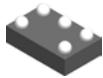
4214839/K 08/2024

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

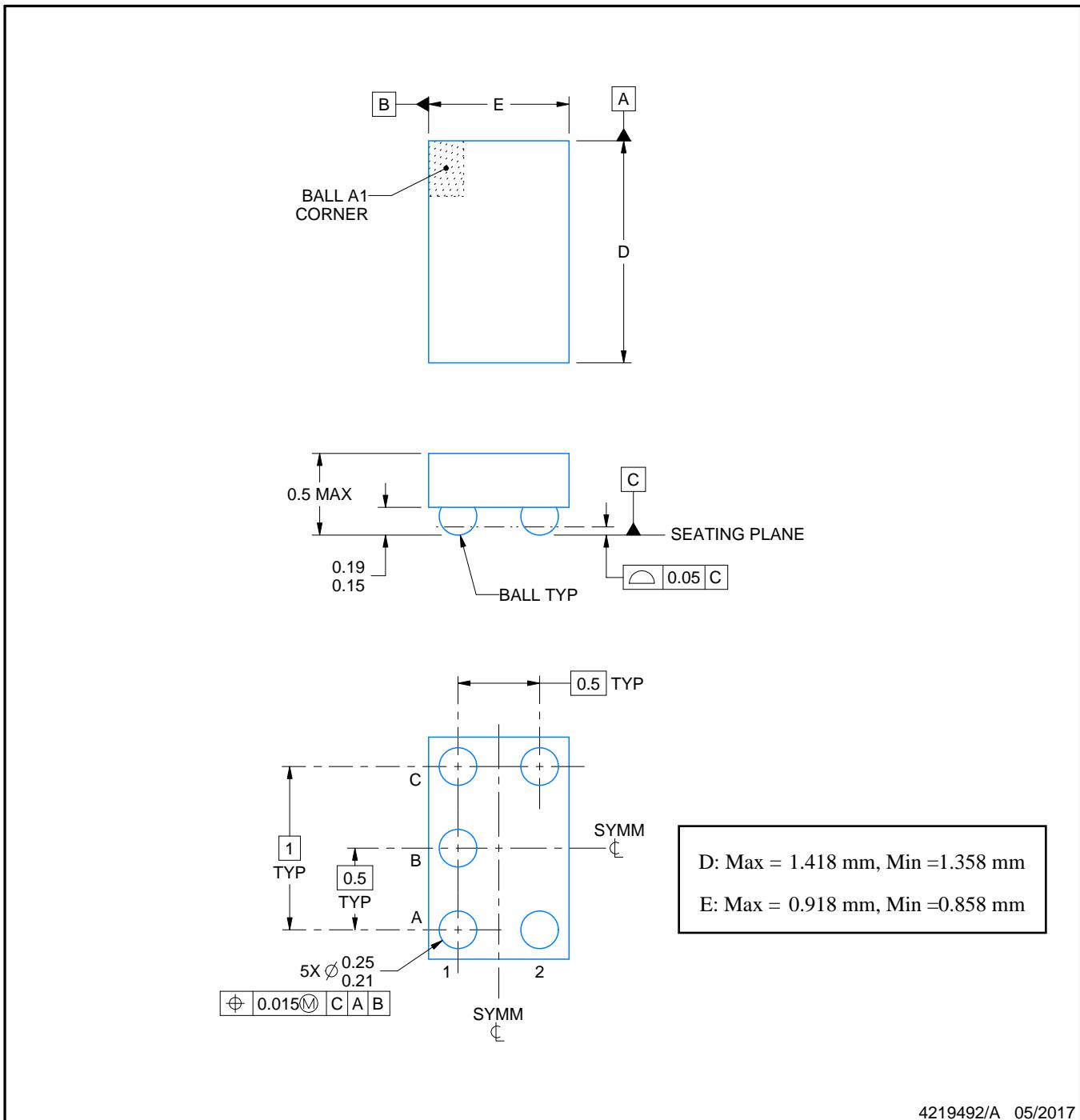
# PACKAGE OUTLINE

**YZP0005**



**DSBGA - 0.5 mm max height**

DIE SIZE BALL GRID ARRAY



4219492/A 05/2017

## NOTES:

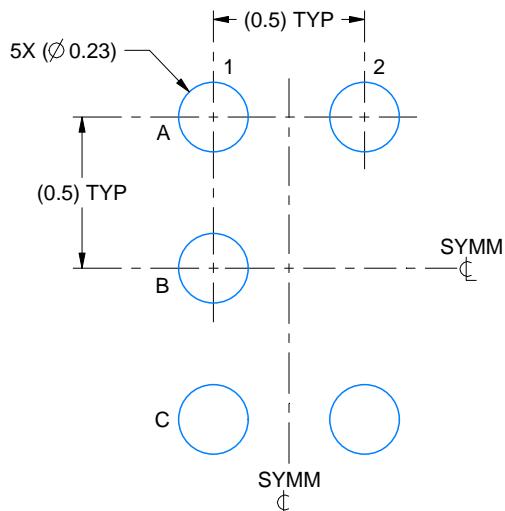
- All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- This drawing is subject to change without notice.

# EXAMPLE BOARD LAYOUT

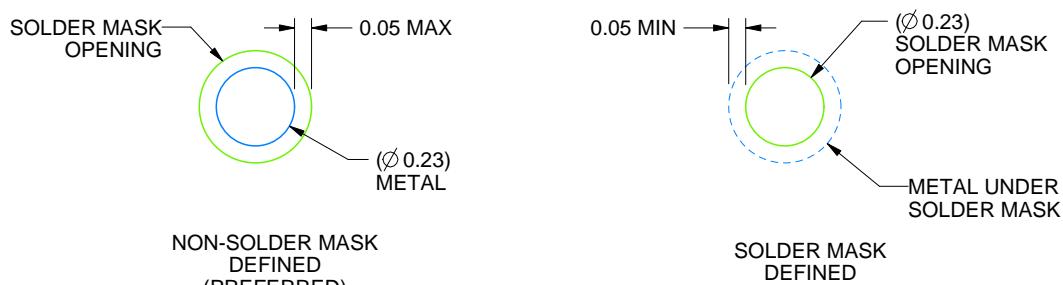
YZP0005

DSBGA - 0.5 mm max height

DIE SIZE BALL GRID ARRAY



LAND PATTERN EXAMPLE  
SCALE:40X



SOLDER MASK DETAILS  
NOT TO SCALE

4219492/A 05/2017

NOTES: (continued)

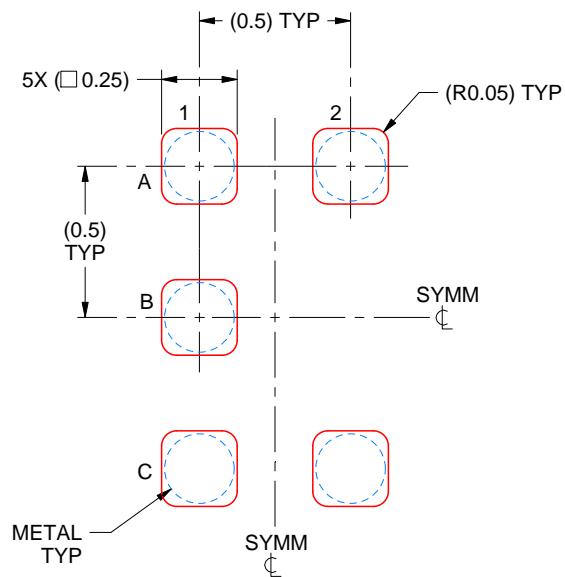
- Final dimensions may vary due to manufacturing tolerance considerations and also routing constraints.  
For more information, see Texas Instruments literature number SNVA009 ([www.ti.com/lit/snva009](http://www.ti.com/lit/snva009)).

# EXAMPLE STENCIL DESIGN

YZP0005

DSBGA - 0.5 mm max height

DIE SIZE BALL GRID ARRAY



SOLDER PASTE EXAMPLE  
BASED ON 0.1 mm THICK STENCIL  
SCALE:40X

4219492/A 05/2017

NOTES: (continued)

4. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release.

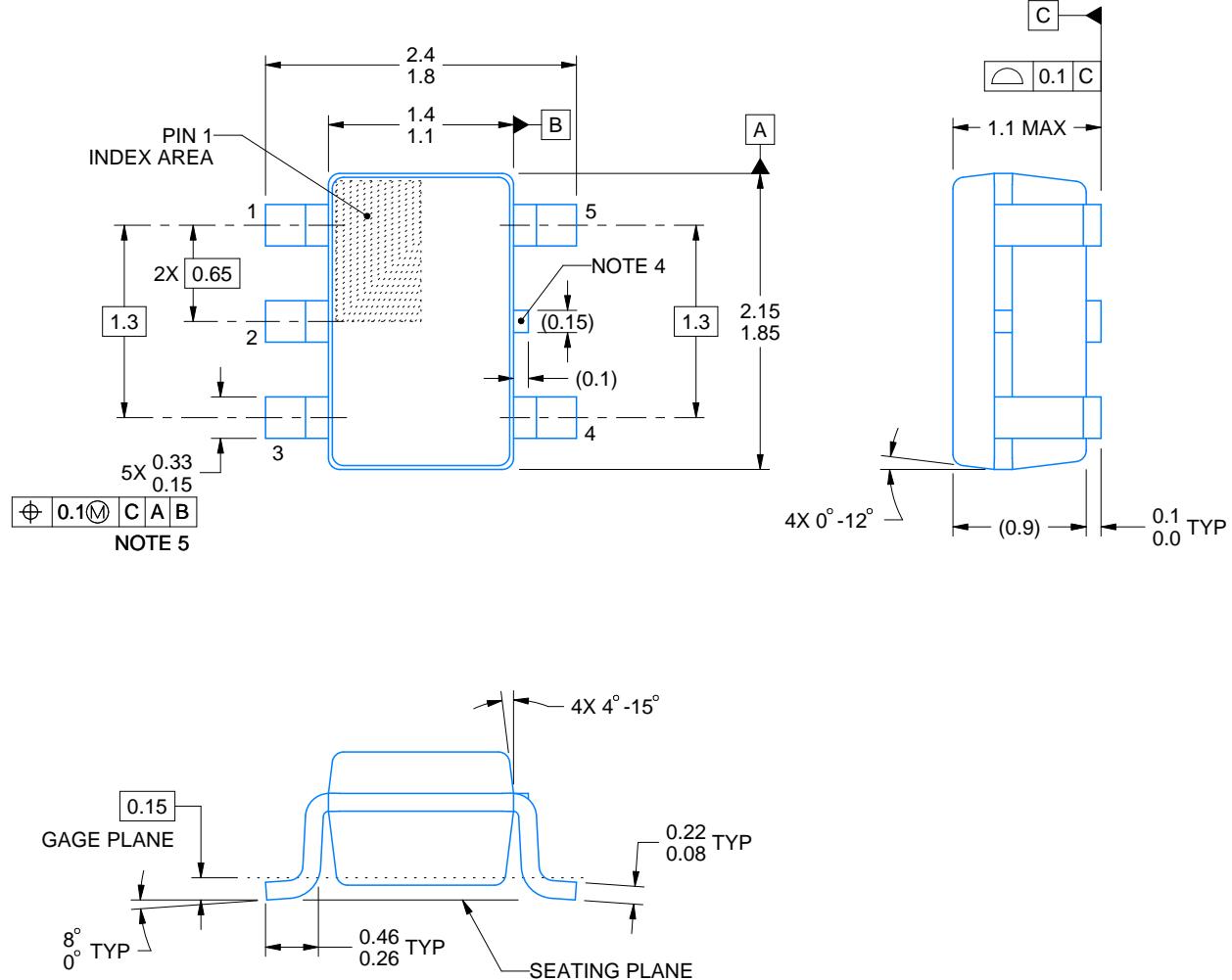
# PACKAGE OUTLINE

DCK0005A



SOT - 1.1 max height

SMALL OUTLINE TRANSISTOR



4214834/G 11/2024

## NOTES:

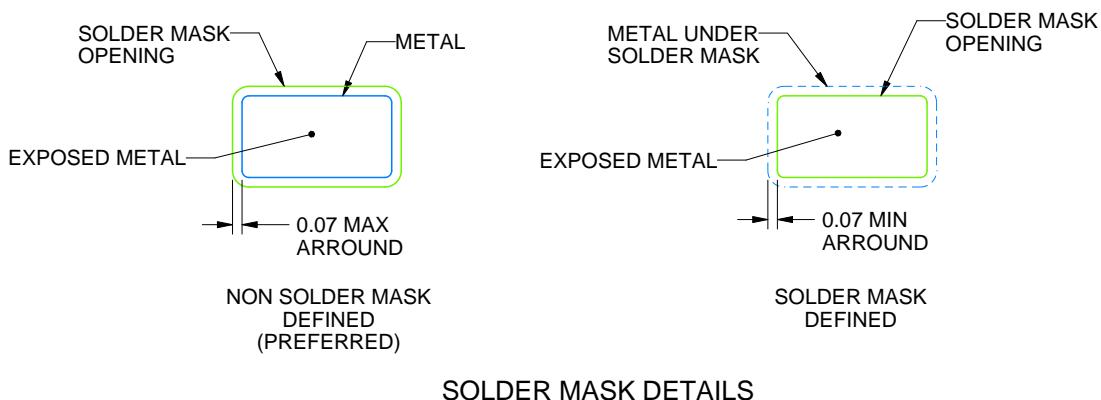
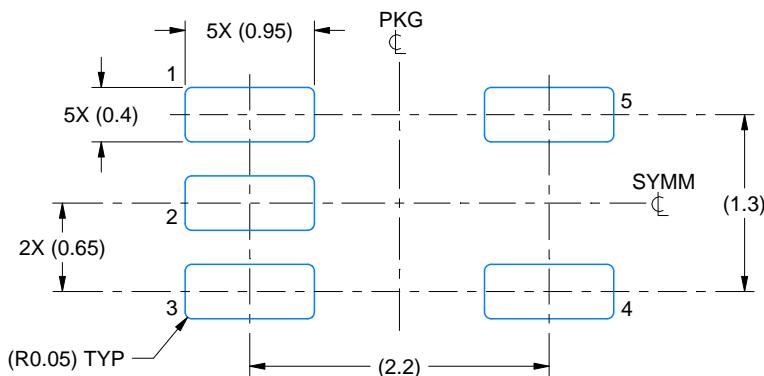
- All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- This drawing is subject to change without notice.
- Reference JEDEC MO-203.
- Support pin may differ or may not be present.
- Lead width does not comply with JEDEC.
- Body dimensions do not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.25mm per side

# EXAMPLE BOARD LAYOUT

DCK0005A

SOT - 1.1 max height

SMALL OUTLINE TRANSISTOR



4214834/G 11/2024

NOTES: (continued)

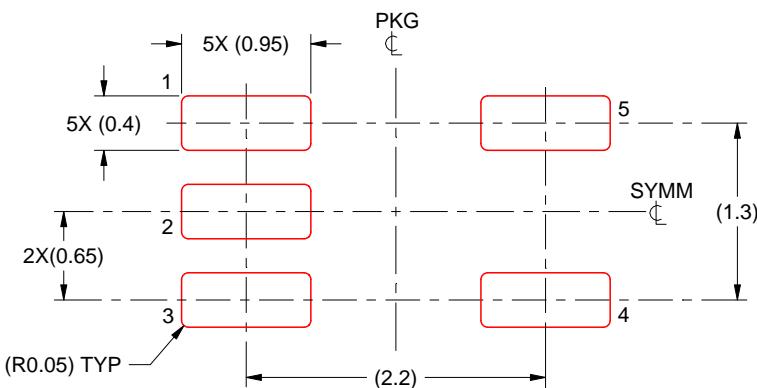
7. Publication IPC-7351 may have alternate designs.
8. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

# EXAMPLE STENCIL DESIGN

DCK0005A

SOT - 1.1 max height

SMALL OUTLINE TRANSISTOR



SOLDER PASTE EXAMPLE  
BASED ON 0.125 THICK STENCIL  
SCALE:18X

4214834/G 11/2024

NOTES: (continued)

9. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
10. Board assembly site may have different recommendations for stencil design.

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